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# MACROMODULAR COMPUTER DESIGN PART 2 MANUFACTURING DESCRIPTION

VOLUME I

# GENERAL STANDARDS AND SYSTEM MAINTENANCE

Technical Report No. 30

FINAL REPORT - FEBRUARY, 1974 CONTRACT SD-302 (ARPA) COMPUTER SYSTEMS LABORATORY WASHINGTON UNIVERSITY ST. LOUIS, MISSOURI MACROMODULAR COMPUTER DESIGN FINAL REPORT - CONTRACT SD-302 FEBRUARY, 1974

# Technical Report No. 30

# PART 2 - MANUFACTURING DESCRIPTION VOL. I-GENERAL STANDARDS AND SYSTEM MAINTENANCE

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The views and conclusions contained in this document are those of the authors and should not be interpreted as necessarily representing the official policies either expressed or implied, of the Advanced Research Projects Agency or the U.S. Government.

> Computer Systems Laboratory Washington University St. Louis, Missouri

# ABSTRACT

Metal finishes, assembly specifications for printed circuit boards, standards for manufacture of printed circuit boards, description of electrical and mechanical properties of macromodular data and control cables, manufacturing specification of Sprague LTN-2 and LTN-3 resistor networks, description and data sheets of BERNE, Inc. CTS 750 cermer resistor networks, wiring paths and pictorial assembly drawings of types of faceplate subassemblies are given.

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#### METAL FINISHES

Specification MF-1

#### I. Introduction

The most prevalent structural material in the Macromodular Computer System is aluminum, in several popular alloys. This specification describes a decorative and protective finish, and gives an outline of the processing steps required.

#### II. Decorative Finish

This document is a performance specification rather than a specific manufacturing recipe. The general description which follows gives an outline of the process; but due to the many variables in the metal finishing industry, samples must be provided for the approval of CSL by any new vendor or by any vendor who wishes to change an established processing sequence.

The desired finish is a clear anodize coating of low reflectance. All surfaces shall be smooth (32 microinch or less roughness) and have a uniform matte finish. In addition, the metal finish procedure must not alter in any way the physical size of a component such that the manufacturing tolerances are exceeded. In the event that this should occur manufacturer and metal finisher must decide on a course of action to correct this problem. A successful process has been:

- 1. Glass Ball Peen
- 2. Caustic Etch
- 3. Sulfuric Acid Anodize

Each of these steps requires some clarification, based upon painful past experience.

#### III. Glass Ball Peening

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Glass Ball Peening is frequently used for deburring and for stress relief, but some adjustments must be made to achieve the MF-1 finish. The processor should use the smallest available glass ball, and a lower air pressure than for stress relieving.

Thin section panels must be peened on both sides, and care must be taken to achieve an even surface. Parts shall be supported by simple jigs to prevent deformation when necessary.

#### IV. Caustic Etch

After the aluminum parts are completely cleaned of glass residue, they are given a light caustic etch. The strength and period shall be controlled to bring out the grain in rolled materials. In no case shall the parts be etched long enough to remove or enlarge holes.

#### V. Sulfuric Acid Anodize

The aluminum parts shall be anodized by a process similar to Alcoa Alumilite 201. The coating thickness shall be approximately 0.0002 inches.

The color of the coating may vary over the several alloys used. The color is not as important as the freedom from blemishes and the uniformity of the matte finish.

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#### VI. Qualification

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Any new vendor will be given samples of properly finished articles. The vendor must then produce samples in his own process and return them to CSL for approval. This approval must be obtained before any substantial runs are made, as parts will be rejected for poor finish.

#### Specification MF-2

This specification, MF-2, is essentially a black anodize finish for various aluminum parts in the macromodular system requiring a decorative and protective finish. As such, proper care in preparation and execution of the finishing process must be exercised in order that a uniform surface finish results from the process. This will usually require caustic etch to remove any surface residues that may interfere with achieving uniform finishes. In no case should etch continue long enough to seriously alter specified dimensional accuracy of parts. In the event that this should occur vendor and metal finisher must decide on a course of action to correct this problem.

This document is not intended to indicate a specific anodize procedure. Due to the many variables in the metal finishing industry the vendor must produce samples in his own process and return them to CSL for approval. This approval must be obtained before any production runs are made as parts will be rejected for poor finish. Samples of properly finished articles will be provided by CSL upon request.

# Specification MF-3

The intent of this specification, MF-3, is to caution the vendor against surface damage to finished parts while undergoing assembly. As care has been taken to achieve a decorative and protective finish for certain parts in the macromodular system it is essential that similar care be exercised during operations of assembly involving riveting, insertion of screws, fitting of parts or any other procedure which may jeopardize the cosmetic and protective qualities of finishes.

Before production assembly of parts begins the vendor must produce samples of completed assemblies and submit them to CSL for approval. This approval must be granted as parts will be rejected for damage in assembly.

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# Two-Sided Plated Through Circuit Board

General Specification PC-1

#### I. <u>Scope</u>:

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This document provides general specifications for two-sided printed circuit boards with solder plated plated-through holes for use in macromodule subassemblies. These general specifications apply to all circuit board types <u>unless specific exception is made</u> within the documents describing a particular circuit board type.

#### II. Material:

Material is to be type FR-4 glass epoxy laminate with 1 oz. copper on both sides. Initial laminate thickness before plating and etching is to be 0.0625 + or - 0.005 inches.

#### III. Plating:

Finished thickness of copper on conductors, pads and terminal areas shall be from 0.002 to 0.003 inches. Thickness in holes is given below. A layer of lead-tin alloy shall be plated to a depth of 0.0003 to 0.0007 over all copper surfaces. All circuit boards shall have the solder plating on both surfaces reflowed by means of a hot peanut oil, hydro-squeegee, or similar process in order to melt back plating overhang. Final plated surface shall be free of contamination and shall be free from defects that may be detrimental to good soldering.

When areas of gold plating are specified (such as contact fingers), there shall be a minimum of 0.000050 inches of gold over a minimum of 0.000150 inches of nickel. The gold shall be free of porosity or nodules.

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# IV. Etching:

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Areas not intended to have conductor shall be etched free of any copper residue. Undercutting should not exceed copper thickness. Undercutting should not produce splinters along conductor edges.

## V. Dimensional tolerances on final etch pattern:

A. Conductor paths corresponding to 0.050 tape in the 4:1 artwork shall have a minimum width of 0.009 inch and a maximum width of 0.015 inch. Width as narrow as 0.005 inch is acceptable for a distance not exceeding 0.020 inch along a line, but not in the area where a line joins a pad. No more than five such narrowings are allowable on one surface of any circuit board.

B. Width greater than 0.015 inch shall be acceptable if minimum clearances are maintained between conducting paths and providing that no more than 10% of the length of a given line exceeds a width of 0.015 inch.

C. A minimum clearance of 0.007 inch between adjacent conducting areas shall be maintained.

#### VI. Plated-through holes:

A. Four plated-through hole types are general used. Additional platedthrough and non-plated-through hole types may be specified for individual board designs.

Type "A" holes, for special components, are plated
 through with a finished diameter after copper and solder plating of 0.045 to
 0.051 inches.

2. Type "B" holes, for male and female amp modu connectors and component leads, are plated through with a finished diameter after copper and solder plating of 0.033 to 0.037 inches.

3. Type "C" holes, for special components, are plated through with a finished diameter after copper and solder plating of 0.069 to 0.077 inches.

4. Type "D" holes, for special components, are plated through with a finished diameter after copper and solder plating of 0.057 and 0.065 inches.

5. Type "E" holes, for special components, are plated through with a finished diameter after copper and solder plating of 0.142 to 0.152 inches.

B. Holes should be plated through unless otherwise specified. Finished Plating thickness of copper on the wall of the hole shall be a minimum average of 0.001 inch as measured at three points at least 0.010 inches apart. No single measurements shall be less than 70% of this minimum. Pinholes, voids, pits and projections are excluded from these measurements.

C. No more than three voids per hole are permitted. Total area of the voids shall not exceed 10% of the total wall area. Largest dimension not to exceed 25% of the core circumference or 25% of the thickness of the board.

D. No plated hole shall have voids or pits at the junction of the hole wall and terminal area to a depth of 1 1/2 times the total copper thickness on the surface.

E. Hole diameter tolerances given apply prior to the reflow operation. Reduction of hole diameter of 15 percent or less during reflow is acceptable.

#### VII. Unplated holes:

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Registration and reference holes are not plated through, and generally are 0.093 + or -0.003 inches unless otherwise shown on individual board documents. Additional types may be specified for individual board designs.

VIII. Hole positioning:

A. Drilling coordinates may be referenced either to artwork or to registration holes or both on a specific circuit board. This is designated separately for each circuit board type.

B. All holes of a given size are to be registered to within  $\pm 0.003$  . inches of true position with respect to other holes of the same size.

## IX. Artwork:

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A. Artwork for circuit boards is prepared as follows: Master Pad Patterns are taped at 4:1 on 7 mil mylar on an etched glass grid plate with 0.050 spacing between grid lines. Cronaflex prints made from the Master Pad Pattern are used for taping the artwork for both sides of the circuit board to ensure registration.

B. Minimum clearance of 0.045 is maintained between taped regions that are not in contact. This minimum clearance generally occurs only at the nearest approach of a printed circuit line to a pad.

C. Minimum pad size of 0.250 inch 0.D.

D. No conducting paths are taped with tape less than 0.050 inches wide.

E. Artwork is generally supplied in the form of 4:1 Cronaflex contact prints of the taped artwork. The Cronaflex print may contain small amounts of tape used for adjustments or corrections. These Cronaflex prints should be returned to Washington University following their use in preparing reductions.

## X. Artwork Identification:

A. All artwork is identified by a number appearing on the artwork within the region that will be reproduced on the circuit board. Artwork for the two sides of a circuit board bears an identical number, typically in the form XXX NNNN-N, where X designates letters A through Z and N designates numbers 0 through 9. All letters and numbers of this group are significant and should correspond exactly on the artwork for the two sides of a specific board. Two additional letters may follow the above identifying number. They are for reference only and are not a part of the artwork identification number.

B. Numbers are to be reproduced so that they are right-reading on the completed circuit board.

## XI. Board finish:

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When specified, the component side of the circuit board will have a screened pattern for component identification applied. The material applied shall be non-conductive, permanent, and resistant to materials and procedures used in board assembly, inspection, and cleaning.

Delivered circuit boards shall be free of scratches, abrasions, other physical damage, and contamination by foreign substances or residues. Any damage that exposes copper underlying solder plating is cause for board rejection.

# XII. Board packaging:

Circuit boards shall be shipped in individual plastic covers to prevent contact between the surfaces of adjoining circuit boards and to protect board from abrasion. They shall be secured so as to prevent slipping against one another during shipment.

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# MANUFACTURING SPECIFICATION

LINE TERMINATION NETWORK LTN-2

# July 15, 1968

# Revised January 4, 1971

# INTRODUCTION:

This specification describes a four resistor network which will be used to terminate high speed pulse transmission lines. The network shall be manufactured in the Sprague Metanet technology or equivalent.

# ELECTRICAL CHARACTERISTICS:

The network shall consist of four 130 ohm  $\pm 1\%$  resistors with a power rating of 120 milliwatts. The resistors shall have a temperature coefficient of  $\pm 500$  ppm/°C or less over an ambient temperature range of  $-55^{\circ}$ C to  $+85^{\circ}$ C.

# MECHANICAL CHARACTERISTICS:

The four resistors shall be packages in an 8 lead ceramic package with maximum overall dimensions of  $0.125" \times 0.350" \times 0.900"$ . The leads shall be #24 AWG tinned copper wire, spaced at multiples of  $0.100" \pm 0.005"$ . The leads shall be 0.5" minimum length.

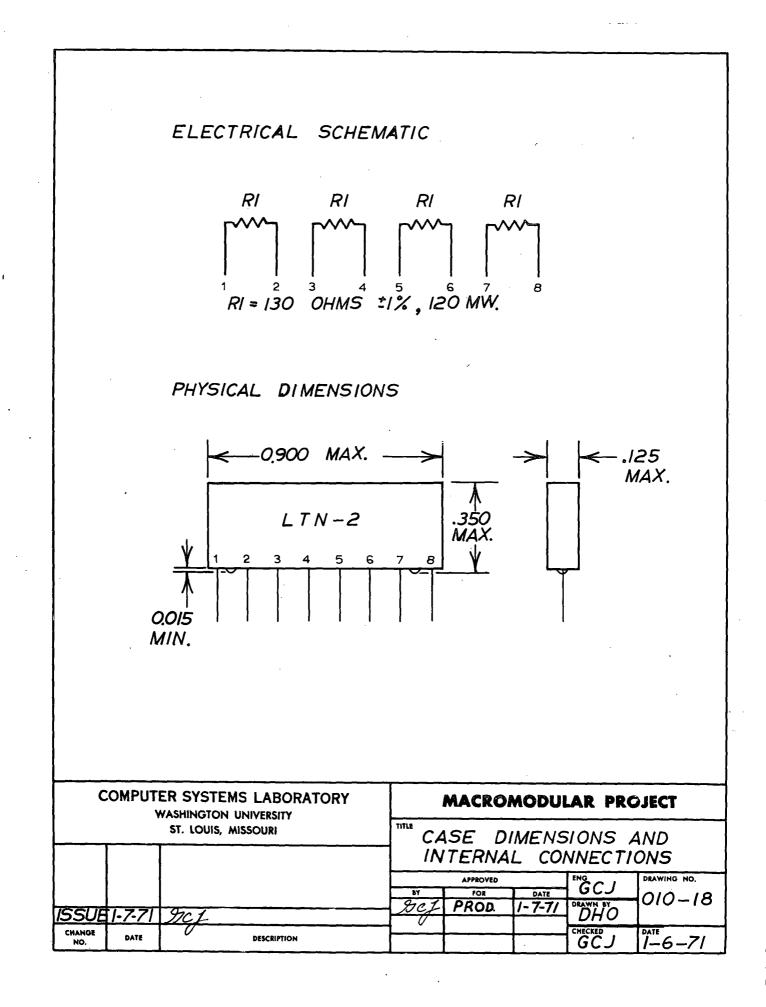
# GENERAL:

An electrical schematic and a package outline sketch are included with this specification. The package is to be identified with the marking LTN-2, and the leads are to be numbered 1 through 8.

# **RESISTOR CHARACTERISTICS:**

1. <u>Power Rating</u>: The power rating of each resistor is as specified and is based on continuous operation up to 85°C.

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#### October 13, 1970

# Manufacturing Specification LIN-3 Terminating Network

## Introduction:

This specification describes a ceramic base resistor-capacitor network designed in the Sprague "Bulplate" technology. The general specifications and descriptions are contained in Sprague Engineering Bulletin 6600A, July 1966.

#### Resistors:

The resistors are the standard thick film resistors of the Bulplate series. There are two values, 1290 ohms and 488 ohms, both at a tolerance of plus or minus 20 per cent and a power rating of 1/5 watt.

#### Capacitors:

The three capacitors are intended to bypass interfering signals with frequencies as low as 10 megahertz. The capacitors should be as large as possible while maintaining minimum seated height and a voltage rating of 10 volts. The capacitors are shown as being distributed on the schematic, but may be discrete chips if so specified by Sprague. A nominal value of 30 pfd is considered adequate.

#### General:

The maximum voltage which will be applied to this network in service is 5.2 volts.

The case shall be marked with the terminal numbers as shown on the outline drawing, and the designation LTN-3.

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- <u>Resistance</u>: The resistance values shall be within the specified tolerances for each resistor. Measurements shall be made at 3VDC and 25°C or else referred to measurements at that voltage and temperature.
  - Note: Resistor elements in series with other circuit elements may not be directly measurable. In such cases, impedance measurements may be necessary. Also some circuit configurations may include closed resistance loops which require extra calculations to determine individual resistant values.
- 3. <u>Voltage Rating</u>: The maximum voltage rating on any resistor shall be determined by the maximum power rating specified.
- 4. <u>Short Time Overload</u>: All resistors shall withstand for five (5) seconds a voltage equal to 2.5 times the rated continuous voltage without exhibiting a permanent change of more than  $\pm 1\%$  of the resistance value.
- <u>Temperature Coefficient</u>: The temperature coefficient of all resistors shall be within ±500 ppm/°C for operation in temperature range of -55°C to +85°C.
- Humidity Resistance: After exposure for a period of 250 hours to an atmosphere of 95% relative humidity at a temperature of 65°C and one hour exposure of 40% maximum relative humidity at 25°C, the maximum resistance change shall be 1.0%.

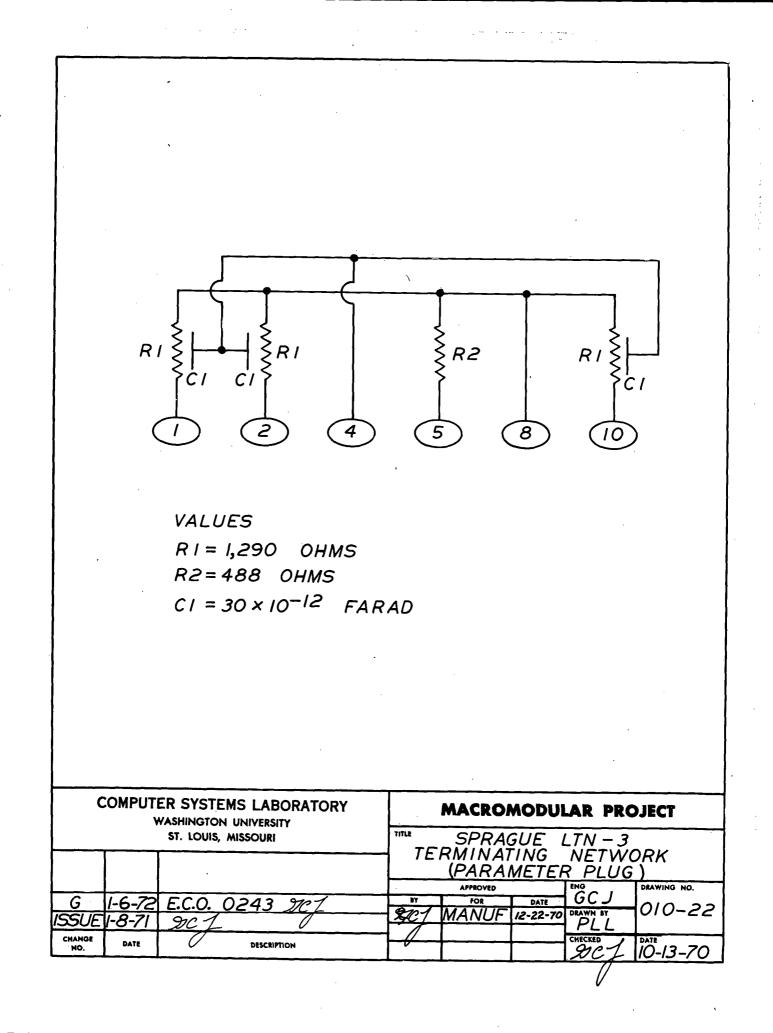
No more than one (1) failure shall be permitted in twelve (12) units tested.

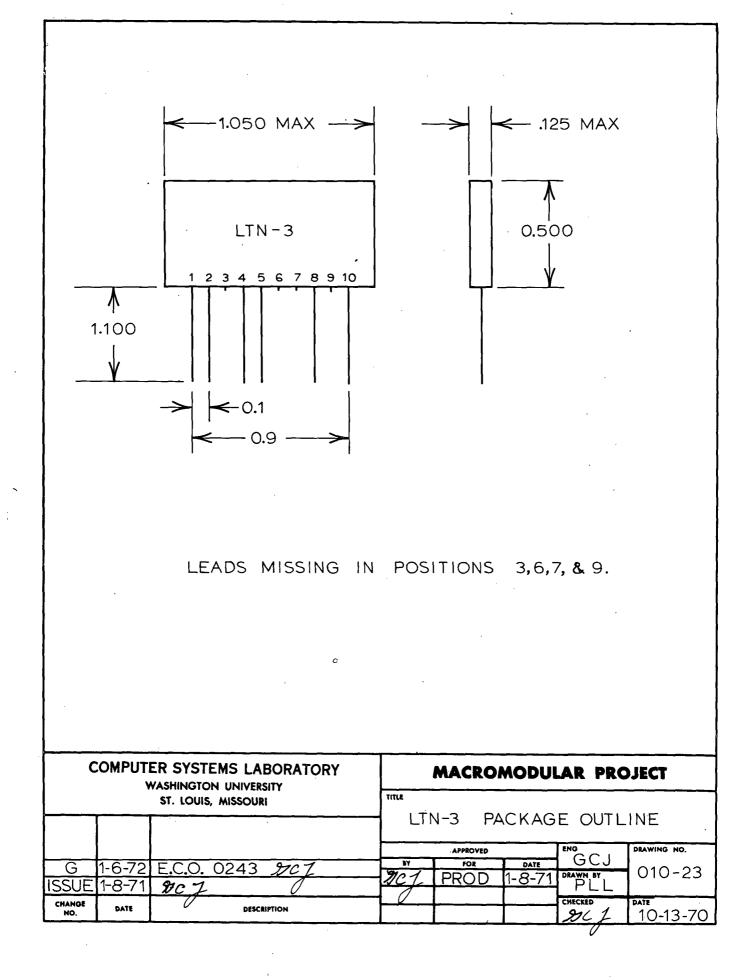
7. Life Test: When these resistors are operated at rated wattage and  $85^{\circ}$ C for 1,000 hours, the maximum change in resistance shall be less than  $\pm 1\%$  for all resistance values.

No more than one (1) failure shall be permitted in twelve (12) units tested.

8. <u>Temperature Cyclying</u>: Resistors shall show no mechanical damage nor change of resistance greater than  $\pm 1\%$  when subject to 5 temperature cycles from  $\pm 25^{\circ}$ C to  $\pm 55^{\circ}$ C to  $\pm 85^{\circ}$ C to  $\pm 25^{\circ}$ C.

No more than one (1) failure shall be permitted in twelve (12) units tested.





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# General Printed Circuit Board Assembly Specification

General:

This specification covers the component assembly on three Macromodular board types, the vertical board, the long and short mother boards. It does not cover the assembly of the Power Supply board which is covered separately by specification 010-35thru 40. These boards are two sided 0.062" FR-4 laminate with plated through holes. For plating, hole dimensions and other details see Printed Circuit Specification PC-1. After cleaning, boards should be handled by the edges to avoid contamination of circuit surfaces with perspiration and skin oils. If surface contact is unavoidable, clean cotton gloves should be worn. Surfaces of areas used to handle or store circuit boards should be kept clean and free of material that might contaminate or damage board surfaces, and covered with carpeting or similar protective material. Circuit boards shall not be stacked on top of one another without the use of protective separators.

# Components:

# 1. Integrated Circuits:

a. Integrated circuits are 14 pin or 16 pin dual-in-line packages of the Motorola MC1000-P (plastic), MC1000-L (ceramic), or MC1200-L (ceramic) series that have been specially tested for use in these circuit boards. The dimensions and identifying marks are specified by the attached Motorola General Information Sheets for these series, pages 0.2-6. Parts are identified on assembly documents by a special number assigned by Washington University, consisting of the letter "M" followed

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by two numerals and possibly a suffix letter (e.g. MOIB). In general, the two digits in our designation match the last two digits of Motorola's part number. Material from the Motorola MC1000 series or MC1200 series in either the plastic or ceramic package <u>may</u> qualify according to our tests for interchangeable use in a particular circuit location. Parts are supplied by us with no additional identification other than the Motorola identification, except that parts bearing a suffix letter (e.g. MOIB) bear an identifying colored dot.

The color code of the dot is as follows:

| No color dot | No suffix |
|--------------|-----------|
| Red          | · ´Α      |
| White        | В         |
| Green        | С         |
| Blue         | D         |
| Yellow       | Ε         |

Parts bearing different color dots should not be interchanged unless such interchange is specifically approved by Washington University. No integrated circuit material not supplied by us or tested to our specifications shall be used.

b. Insertion of integrated circuits is accomplished by use of a special insertion tool, Dual In-Line Insert, #52, made by Techni-Tool. The use of this tool is facilitated by using a small metal block dimensioned to fit between the pins of the package. The block dimensions can be taken from Motorola descriptive literature for this type of integrated

circuit. The integrated circuits are to be inserted fully, so that the shoulders of all pins are in contact with the surface of the printed circuit conductor. In the insertion process, care must be taken that the portions of pins, close to the body of the package, are not compressed excessively in a manner that overstresses the bond of the pin to the body of the package. Pins number 7 and 14 (8 and 16 on 16 pin packages) may be bent over flush with their mounting pad to hold the package in place for soldering. These pins must be trimmed so that they do not extend beyond the edge of the conductor surface to which they are soldered.

# 2. Resistors

- a. Two types of resistors are used. Electra Type MF5C 1/8 watt
   1% metal film resistors comprise approximately 90% of all
   axial lead components. They are fragile and subject to
   breakage by mechanical shock, compression, or lead stress.
   The second type used is Electra Type MF 07C 1/4 watt 5%
   carbon composition. They are supplied in reels and are color
   coded as follows.
  - Solid body color with colored stripe around middle. Stripe color conforms to standard electronic color code and is related to resistor part number in assembly documentation.

Resistor Identification Color Code

RO - Black Stripe - Zero Ohms (Jumper) RI - Brown Stripe - 1.5 K Ohms R2 - Red Stripe - 750 Ohms Resistor Identification Color Code

| R3 - | Orange Stripe   | - 121 Ohms   |
|------|-----------------|--------------|
| R4 - | • Yellow Stripe | - 15K Ohms   |
| R5 - | Green Stripe    | - 57.6 Ohms  |
| R6 - | Blue Stripe     | - 130 Ohms   |
| R7 - | Violet Stripe   | - Unassigned |
| R8 - | Gray Stripe     | - Unassigned |
| R9 - | No color        | - Special    |

# 3. Jumpers:

a. Jumpers are of two types. One type is identical with resistor body and is described above. Where other than standard component hole spacing is used and a jumper must be fabricated to fit, use #24 AWG tinned solid copper wire, encased in Teflon sleeving that provides a snug fit. The sleeving must cover the wire to within 1/16 inch of the point where the wire passes through the plated-through hole.

4. Diodes:

a. Glass body diodes, 1N3604 are used.

5. Capacitors:

Capacitors are Elemenco Dipped Silver Mica Capacitors Type DM-15 500 WVDC 5% with radial leads.

## Assembly:

# 1. Orientation:

Those components requiring orientation, diodes and integrated circuits, have the orientation specified on the assembly document.

Diode polarity is given by the color band designating the cathode end. Integrated circuits have a notch on the end of the package as described above.

# 2. <u>Insertion</u>:

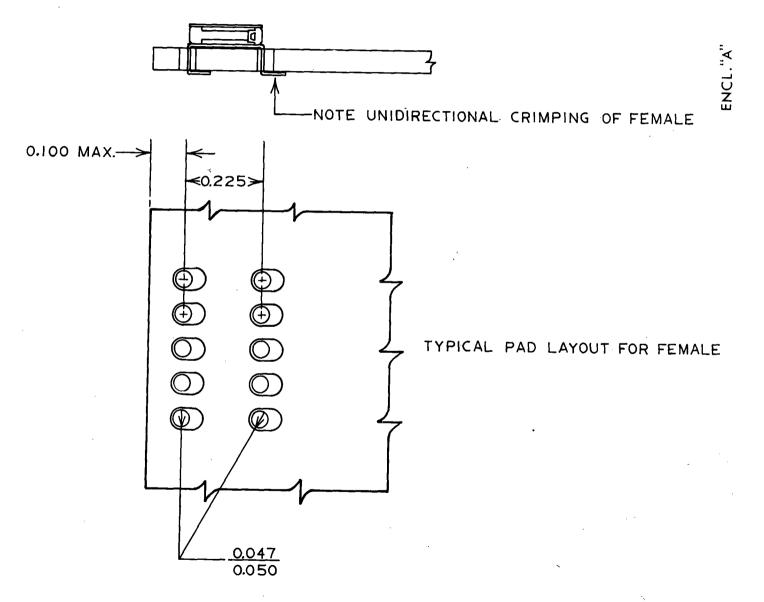
Axial leads are, wherever possible, to be installed in platedthrough holes 0.700 inch apart. Occasionally, mounting holes are a non-standard distance apart. Components for standard mounting holes may be pre-formed and pre-trimmed. Components for non-standard mounting holes need not be pre-formed and in addition the leads should be sleeved with close fitting Teflon sleeving. Leads may be bent, if necessary, for secure mounting during handling and soldering. Bent leads must be trimmed so that they do not extend beyond the edge of the conductor to which they are soldered.

# 3. Female connector sockets:

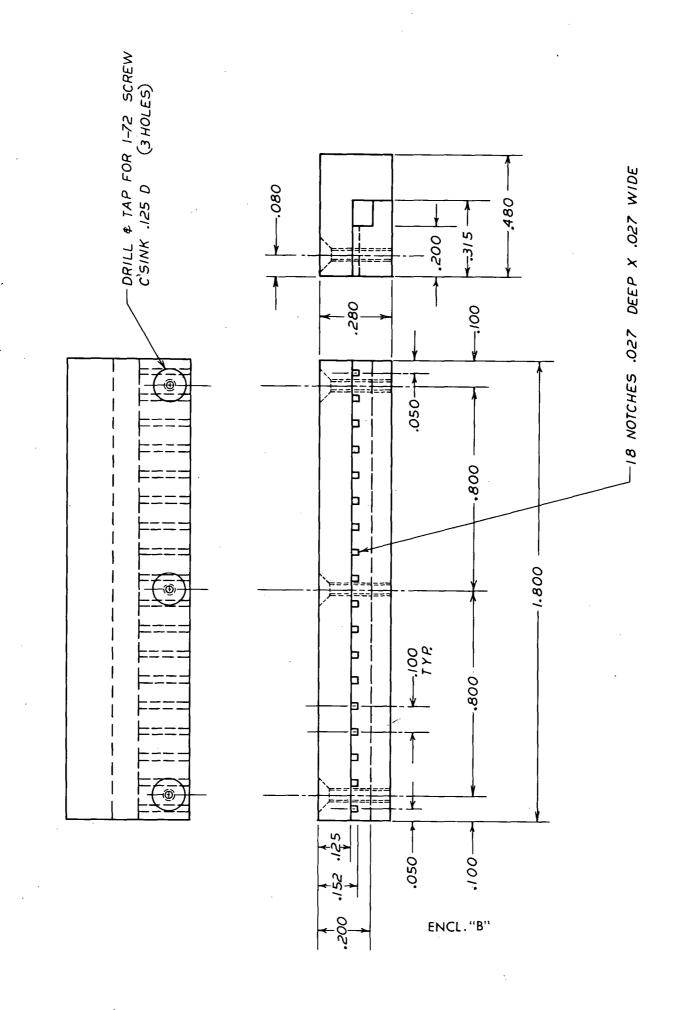
These are AMPMODU Model II type C female sockets with gold-plated finish, AMP number 85863-4, and are furnished as loose pieces. They are used only on the vertical boards and must be oriented as shown on Enclosure A.

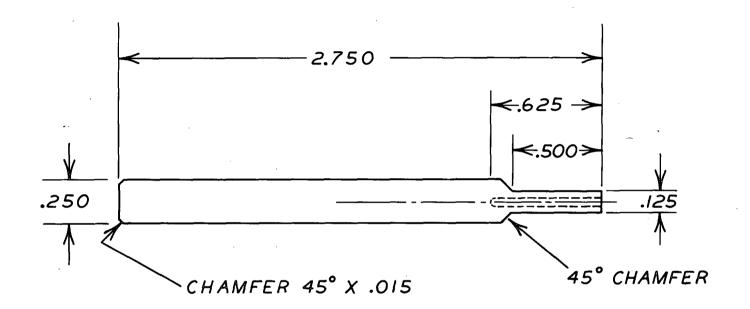
Connectors are mounted by inserting prongs through a pair of plated-through holes spaced 0.255 inch apart. Connector prongs are to be inserted fully so that the connector body is flush with and in contact with the conductor surface of the circuit board. Prongs are bent, as shown in Enclosure "A", so that they are flush with and in contact with the conductor surface of the printed circuit board. Care must be taken to enxure that bending the prongs does not list the connector body from being flush

# VERTICAL BOARD FEMALE INSTALLATION



3

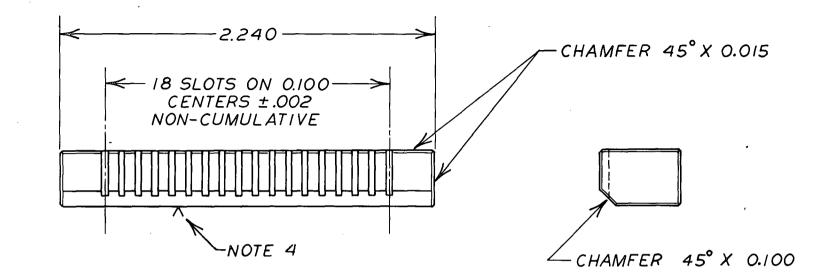


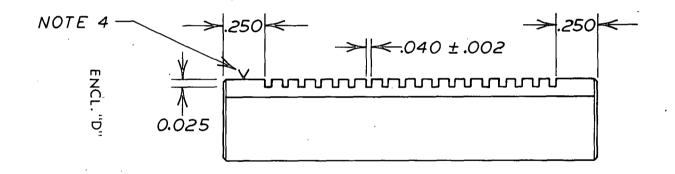


ENCL."C

-.040 D

MATERIAL: .250 DELRIN DIMENSIONS: ±.005

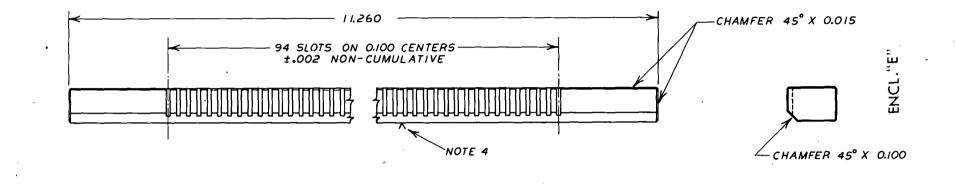


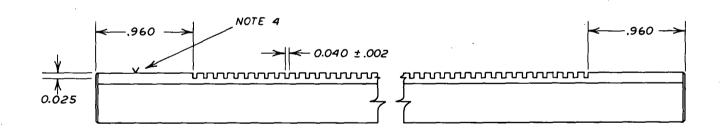


# NOTES

.

- I. DO NOT SCALE FROM PRINT.
- 2. MATERIAL IS T2024-T3 ALUM. "
- 3. TOLERANCES ±.005 U.O.N.
- 4. MARKED SURFACES TO BE MILLED FLAT. 5. EDGES ARE TO BE FREE OF BURRS.

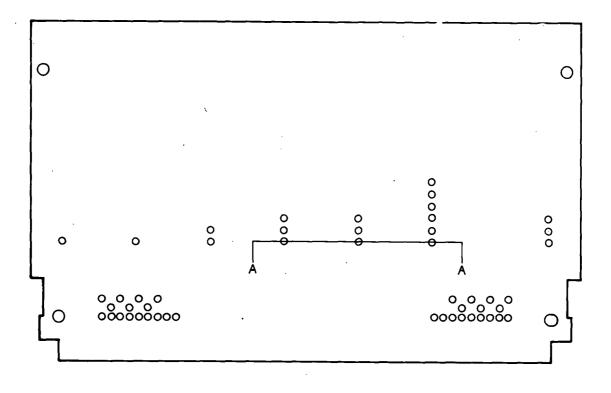




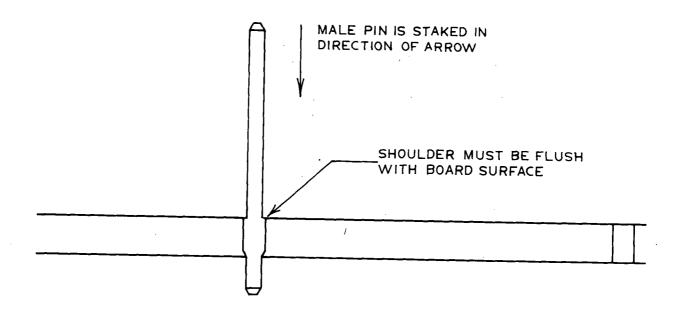
NOTES:

- I. DO NOT SCALE FROM PRINT.
- 2. MATERIAL IS T2024-T3 ALUM
- 3. TOLERANCES ± .005 U.O.N.
- 4. MARKED SURFACES TO BE MILLED FLAT. 5. EDGES ARE TO BE FREE OF BURRS.

MOTHERBOARD MALE PIN ALIGNMENT



SECTION "A-A"

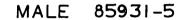


MALE PIN IS PRESS FIT IN 0.036 DIA. HOLE

ENCL."F"

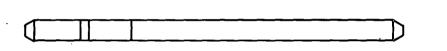


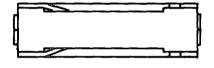




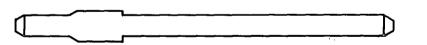
FEMALE 85863-4

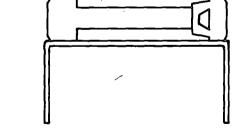
ENCL .''G''













with the printed circuit board surface. Any means of holding the connector sockets flush with the board, during this process, may be used that does not damage the connector.

# 4. <u>Male connector pins</u>:

These are AMPMODU MOD II gold-plated pins, Amp number 85931-5, supplied either on a reel or as loose parts. These pins are used only on the long and short mother boards and are staked in positions shown on individual assembly drawings. Pin shoulders are to be flush with the board surface to within  $\pm$  0.010 inches. See Enclosure "B" for sample staking tool used for this purpose with arbor press. Connector pins are to be inserted in the correct orientation as shown in Enclosure "F" & "G" to within  $\pm$  10 degrees rotation about the long axis. Pin alignment in the vertical shall be checked and corrected by means of alignment tools and pin straightener shown in Enclosures "C", "D", & "E". In no case should pins be straightened by use of metal tools, to avoid nicking the pin, and pins can only be bent a very few times before breaking.

# 5. Resistor Networks:

These are Sprague LTN-2, which are four 130 ohm resistors encapsulated in plastic to form one unit. They are sometimes shown with certain of the leads clipped. Care must be taken when inserting these units that the end of the clipped leads does not touch the circuit board. Scotch brand No. 33 tape shall be placed between the circuit board and the clipped portion of the LTN-2 with care being taken that the clipped ends do not penetrate the insulation material.

# 6. Mother Board Connectors, 90 Pin:

There are two types in use, the long mother board uses AMP 1-202-845-5 and the short mother board uses AMP 583 464-1. The long mother board connectors come individually in plexiglass tubes. The short mother Board connectors come two to a box. The connectors are fastened to the circuit boards by means of brass eyelets, E.B. Stimson A 1425. One of the two connector mounting holes in the circuit board is round and the other elongated to allow for connector tolerances. The eyelet must be fastened in the round hole first and must be pressed and not stamped in order to avoid breaking plastic ear of connector. See drawings 200.50D26, 200.50D27, 200.50D28 and 200.50D29 for proper orientation of connector on board, particularly note side of board that connector ear is in contact with. On the short mother board the right angle connector pins pass through holes in the board. On the long mother board the board is placed between the rows of connector pins. In both cases during assembly and soldering, the connector should be mated

with a female connector to protect pins from damage and to position pins properly within the connector block.

# Soldering:

Soldering may be by flow techniques or hand techniques. Flow solder temperatures should be less than  $600^{\circ}$  F and hand solder tools must be equipped with a temperature controlled tip of  $600^{\circ}$  or less. Higher temperatures will raise the copper from the laminate. When soldering by flow techniques is used, the boards must be baked or preheated to remove residual moisture. If this is not done the heat of the solder bath will

cause the moisture to explode the copper from the laminate. Solder should form a clean, shiny surface with concave fillets. There should be good wetting of the surface of the pad and the component leads. Preferably the solder should penetrate through the plated-through holes and be visible from the component side but this is not a necessity. Proper solder temperature and eutectic control of solder has a direct bearing on this problem. In any case the solder-tin ratio should be properly maintained to do proper soldering.

Extreme care must be taken not to contaminate the female AMPMODU connectors with solder. Any solder on the connector which obstructs the opening for the male pin, contaminates the contact surfaces, or restricts the free motion of the contact springs is cause for rejection.

The male AMPMODU pins shall be free of solder to within 0.120 inch of the board surface. Solder is acceptable within this tolerance provided that it is a thin film rather than a blob or thick layer. <u>Cleaning</u>:

After assembly and after any board repair the boards must be thoroughly cleaned of flux and other residues with DuPont TE35, Freon Flux Remover. Boards should then be scribbed with a nylon bristle brush in a weak detergent solution in water to remove the residue from the flux remover. Boards should then be dried with a clean air blast to remove the water and any other foreign materials, slivers, clipped wire leads, etc. that might have lodged under the components.

#### Inspection:

1. Presoldering Inspection:

Before any assembly starts the printed circuit board should be examined to see that it is clean and free from oil, fingerprints,

dirt, moisture and other foreign material. The Institute of Printed Circuits, Inc. 1717 Howard Street, Evanston, Illinois 60202 puts out a book titled "Acceptability of Printed Circuit Boards" which shows what to look for in this inspection. After assembly and before soldering, the boards should be inspected for proper component insertion and orientation. Correct component identification should be verified and all errors corrected before soldering.

2. Final Inspection:

#### Soldering:

All component leads requiring soldering are to be inspected for proper soldering and retouched as needed. As a general rule, solder touch up on the component side should be avoided. However when component side soldering is necessary, extreme care should be exercised to avoid creating solder bridges between closely mounted leads. Touch up of female AMPMODU connections generally leads to solder contamination of the connector. Touch up around the male AMPMODU pins tends to wick solder up the pin. Generally no solder should be found on any connector surface other than the portion in contact with the printed circuit board. Care should be taken to differentiate between cold solder joints and dull discolored joints which resemble cold solder joints. Nicks in copper paths greater than 30% of the conductor width are unacceptable.

Severe dewetting that leaves bare copper exposed is unacceptable. Scratches or gouges causing functional board damage are unacceptable.

External stains, residue or contaminates between or adjacent to either conductors are unacceptable.

#### Circuit Board:

Any physical damage to the conductors or separation from the laminate base material is cause for rejection. Circuit board warpage that can be corrected by a five pound flattening weight is acceptable.

Trimming:

All component leads shall protrude less than 0.10 inch beyond the circuit board surface except 0.05 inches on short mother boards. All bent leads shall be trimmed so that they do not extend beyond the edge of the pad to which they are soldered. Components:

Components should be examined for chipping and cracks. Resistors are susceptible to hair line cracks if lead bending is done improperly. Top of integrated circuits tend to separate from body if unit is improperly mounted so that a torque is present. Male AMPMODU pins bend very easily if board is mishandled. Female AMPMODU pins tend to stand up from board if not help properly when bending prongs. Check to see that no component lead is touching a copper path passing under it.

#### Shipping:

Printed circuit boards must be packed for shipment in such a manner that will effectively protect them from contamination and physical damage.

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# Printed Circuit Board Repair Criterion

- A. Defects on circuit boards found during inspection shall be corrected in a manner that will leave the resulting circuit board as similar as possible in appearance and reliability to a perfect board. Solder touch-up must be done with a temperature-controlled soldering iron such as the Weller WTCP, thermostatically controlled not to exceed a tip temperature of  $600^{\circ}$  F.
- B. Replacement of damaged or defective components shall be accomplished by first removing the excess solder by means of a vacuum device, then clipping off leads, and finally removing the leads one at a time. The printed circuit board shall be examined for evidence of separation of laminate after component removal and before insertion of a replacement component. The replacement component shall be of a type identical to that replaced unless specific approval is given for a a substitution.
- C. Repair of defective or delaminated printed circuit conductors shall be made by soldering a piece of teflon sleeved tinned #30 solid wire so as to interconnect the two terminal points of the defective conductor. The defective conductor shall be removed from the circuit board. Conductor runs of greater than two inches will not be repaired in this manner.
- D. Boards shall be cleaned and inspected for residues following any rework.

#### <u>General:</u>

Unless specifically modified herein, general assembly specification 010-24 thru 010-34 applies.

#### Assembly:

- 1. Axial-lead Components:
  - (a) Orientation

Those components requiring orientation (electrolytic capacitors and diodes) have orientation specified on the assembly document. Diode polarity is given by a white band, which designates the cathode end; or a diode symbol on the case of the diode. Capacitor polarity is printed as (+) or (-) on the capacitor body.

(b) Insertion

There is no standard distance between mounting holes. Components are formed to fit. Leads may be bent if required for secure mounting during handling and soldering. Bent leads must be trimmed so that they do not extend beyond the edge of the conductor to which they are soldered.

- 2. Power Transistors:
  - (a) Orientation

The power transistors will fit the mounting holes in only one orientation. In <u>no instance</u> is the orientation to be based upon the transistor identification number or date code orientation.

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#### (b) Insertion

The transistors are to be inserted fully, so that all the dimples on the bottom of the transistor are in contact with the surface of the printed circuit board. The leads may be bent if required for secure mounting during handling and soldering. Bent leads must be trimmed so that they do not extend beyond the edge of the conductor to which they are soldered.

## 3. Inductors:

(a) Orientation

L1 may be mounted in two orientations, either is acceptable. L2 must be mounted to provide maximum spacing between L2 and C2. In <u>no instance</u> is the orientation of either inductor to be based on the identification number orientation.

(b) Insertion

The inductors are mounted with RTV silicone rubber between the inductor and the printed circuit board. The inductor feet shall be within 0.020 inches of the printed circuit board and the RTV shall fill at least 3/4 of the area under the inductor. No RTV shall extend more than 0.050 inches beyond the edge of the inductor. The leads may be bent if required for secure mounting during handling and soldering. Bent leads must be trimmed so that they do not extend beyond the edge of the conductor to which they are soldered.

#### 4. Transformers:

(a) Orientation

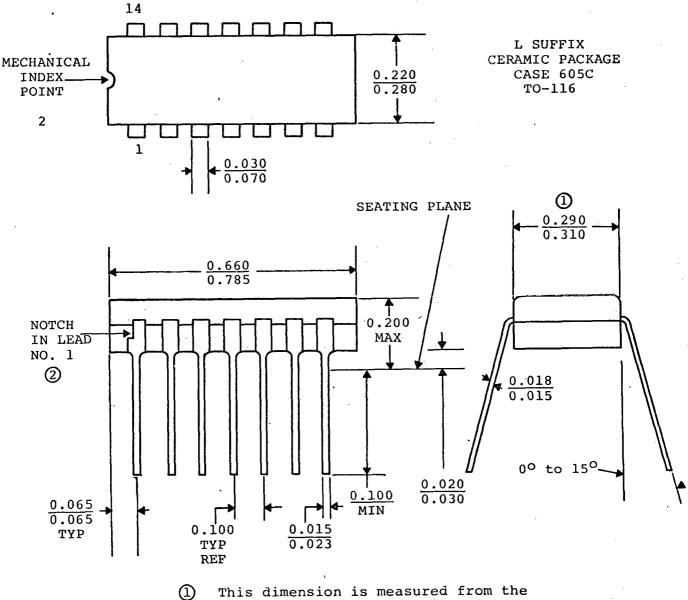
TI can be mounted in only one orientation. T2 must be mounted with the wires extending from the transformer oriented as shown on assembly document. In <u>no instance</u> is the orientation to be based upon the transformer identification number orientation.

(b) Insertion

TI must be inserted fully, so that the feet on the bottom of the transformer are in contact with the surface of the printed circuit board.

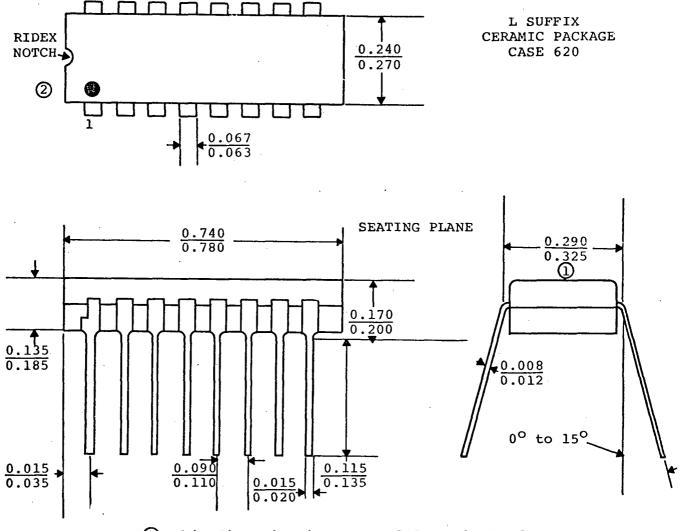
T2 is mounted with RTV silicone rubber between the transformer and the printed circuit board. The transformer is to be inserted fully, so that the shoulders of all pins are in contact with the surface of the printed circuit board. The RTV shall fill at least 3/4 of the area under the transformer. No RTV shall extend more than 0.050 inches beyond the edge of the transformer. The two leads extending from the transformer that are twisted together are inserted into the two holes marked "8" on the printed circuit board. The other two wires are inserted into the holes marked "7" and "9" in any order.

Leads may be bent if required for secure mounting during handling and soldering. Bent leads must be trimmed so that they do not extend beyond the edge of the conductor to which they are soldered.



2

lead centers at the seating plane. Orientation will be indicated either by mechanical index point or notch in pin 1 as shown.



16

- This dimension is measured from the lead centers at the seating plane with leads vertical.
- 2 Lead 1 identified by color dot, notch in lead,or notch in ceramic.

# FREON® T-E 35

# **PRODUCT DESCRIPTION**

"Freon" T-E 35 is a blend of "Freon" TF with 35% specially denatured ethyl alcohol. It is designed to combine the properties of ethyl alcohol with those of "Freon" TF for cold cleaning process.

#### WHERE USED

"Freon T-E 35 provides good solvency for both organic and polar soils. It is one of the most gentle and effective rosin flux removers and is used to clean:

- Printed Circuit Boards
- Hearing Aids
  - Electrical Meters & Timers
- Electrical Relays Precision Capacitors

- Potentiometers.
- Missile Guidance Systems

# COMPATIBILITY

"Freon" T-E 35 is useful for cleaning components whose materials of construction are quite sensitive to strong organic solvents.

## CLEANING PROCESSES

"Freon" T-E 35 is designed to be used only in cold cleaning processes. They include dipping with or without ultrasonics, and flushing. It readily fits into multi-stage operations where it is usually followed by a rinse in "Freon" TF. Since "Freon" T-E is a blend of "Freon" TF and ethyl alcohol, the composition of liquid and vapor will change during evaporation. As it evaporates, the residual solvent will become flammable due to alcohol enrichment.

PACKAGING AND AVAILABILITY

"Freon" cleaning agents are available in 5, 20 and 55 gallon drums, in tank truck and tank car quantities. They can be ordered by contacting these offices:

E. I. du Pont de Nemours & Co. (Inc.) "Freon" Products Division Wilmington, Delaware 19898 Phone: (302) 774-8341

From New York City Area: (212) 265-1391

From Northern New Jersey Area: (201) 622-3680

E. I. du Pont de Nemours & Co. (Inc.) "Freon" Products Division 701 Welch Road Palo Alto, California 94304 Phone: (415) 326-2840

From Southern California: (213) 443-0191

"Freon" cleaning agents are also available from authorized distributors throughout the United States who are identified by this symbol.

Boiling Point at One Atmosphere.

Freezing Point,

Liquid Density at 77°F,

Surface Tension at 75°F.

Solubility of Water at 75°,

Latent Heat of Vaporization

at the Boiling Point,

a. Initial boiling point

Flash Point ..... None to boilb

Color .....Clear, colorless

Toxicity (TLV) ppm by volume ......ca. 1000\*

\*Calculated from recommended Threshold Limit Values for the individual components.

b. None to about 25 volume % evaporation



From all other locations East of the Rocky Mountains: (800) 441-9450

FREON is Du Pont's registered trademark for its fluorocarbon compounds.

The information contained herein is based on technical data and tests which we believe to be reliable and is intended for use by persons having technical skill, at their own discretion and risk. Since conditions of use are outside of Du Pont's control, we can assume no liability for results obtained or damages incurred through the application of the data presented, nor can we assure customers of freedom from patent infringement in the use of any formula or process described herein.

E. I. DU PONT DE NEMOURS & CO. (INC.) • "FREON" PRODUCTS DIVISION • WILMINGTON, DELAWARE 19898



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July 28, 1971

MACROMODULAR DATA CABLE MODEL D SPECIFICATION CAS-6

PREPARED BY: Gerald C Johns 8-5-71

INTRODUCTION:

This specification gives complete electrical and mechanical details for a part which is known as the Macromodular Data Cable Model D. This cable will be used to transmit high speed digital information between modular computer assemblies. The twisted pairs used in this cable will also be packaged separately for a wire harness assembly.

GENERAL:

The wire and cable described here shall conform to the quality and workmanship standards outlined in Brand Rex Commercial Specification BR-212C, November 1966. The Model D cable has insulation materials, color codes, and certain mechanical characteristics which are similar to Brand Rex Type BDW Twisted Pair Buried Distribution Wire (Catalog W668).

INDIVIDUAL CONDUCTORS:

WIRE:

٤

The individual conductors shall be #30 AWG oxygen free copper with a silver coating.

CONDUCTOR: #30 solid OFHC copper NOMINAL DIAMETER: 0.0100 inches

MINIMUM DIAMETER: 0.0099 inches

MAXIMUM DIAMETER: 0.0103 inches

COATING: Silver (not less than 40 microinches thick)

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## INSULATION:

The wires shall be covered with extruded high density, heat stabilized polyethylene.

MATERIAL: extruded polyethylene WALL THICKNESS NOMINAL: 0.007 inches WALL THICKNESS MINIMUM: 0.006 inches WALL THICKNESS MAXIMUM: 0.008 inches COLORS: white, red, yellow, violet, blue, orange, green, brown, and slate MATERIAL DIELECTRIC CONSTANT: 2.34 nominal POWER FACTOR: less than 0.0005 at one megahertz

TWINNING:

There shall be seventeen twisted pairs with colors and pitch as shown in the following table.

| PAIR<br>NUMBER | TIP    | RING   | PITCH<br>(INCHES PER TWIST) |
|----------------|--------|--------|-----------------------------|
| 1              | Violet | Blue   | 1/2                         |
| 2              | Violet | Orange | - 3/4                       |
| 3              | White  | Green  | <b>1</b> ·                  |
| 4              | Red    | Brown  | 1 1/4                       |
| 5              | Yellow | Slate  | 1 1/2                       |
| 6              | White  | Blue   | 3/4                         |
| 7              | Red    | Orange | 1                           |
| 8              | Yellow | Green  | 1 1/4                       |
| 9              | White  | Brown  | 1 1/2                       |
| 10             | Red    | Slate  | 3/4                         |
| 11             | Yellow | Blue   | 1                           |
| 12             | White  | Orange | 1 1/4                       |
| 13             | Red    | Green  | 1 1/2                       |
| 14             | Yellow | Brown  | 3/4                         |
| 15             | White  | Slate  | 1                           |
| 16             | Red    | Blue   | 1 1/4                       |
| 17             | Yellow | Orange | 1 1/2                       |

#### CABLE DESCRIPTION:

The seventeen twisted pairs shall be bunched in a unidirectional lay with the core of the bundle made up of pairs 1 through 5 inclusive. The spatial arrangement of the pairs shall be as close as possible to Drawing 010-46. The bundle of seventeen pairs shall be wrapped with an 0.001 inch Mylar tape with a 10% overlap.

INNER JACKET:

The wrapped bundle shall be covered by an extruded black high density polyethylene jacket.

| MATERIAL:               | high density polyethylene |
|-------------------------|---------------------------|
| WALL THICKNESS NOMINAL: | 0.007 inches              |
| WALL THICKNESS MINIMUM: | 0.005 inches              |
| WALL THICKNESS MAXIMUM: | 0.009 inches              |
| DIELECTRIC CONSTANT:    | 2.34 nominal              |
|                         |                           |

SHIELD:

The jacketed pairs shall be covered by a braided copper shield with a high braid angle.

WIRE: #34 AWG tinned copper

BRAID ANGLE: 50 degrees nominal

WALL-THICKNESS: 0.028 inches nominal

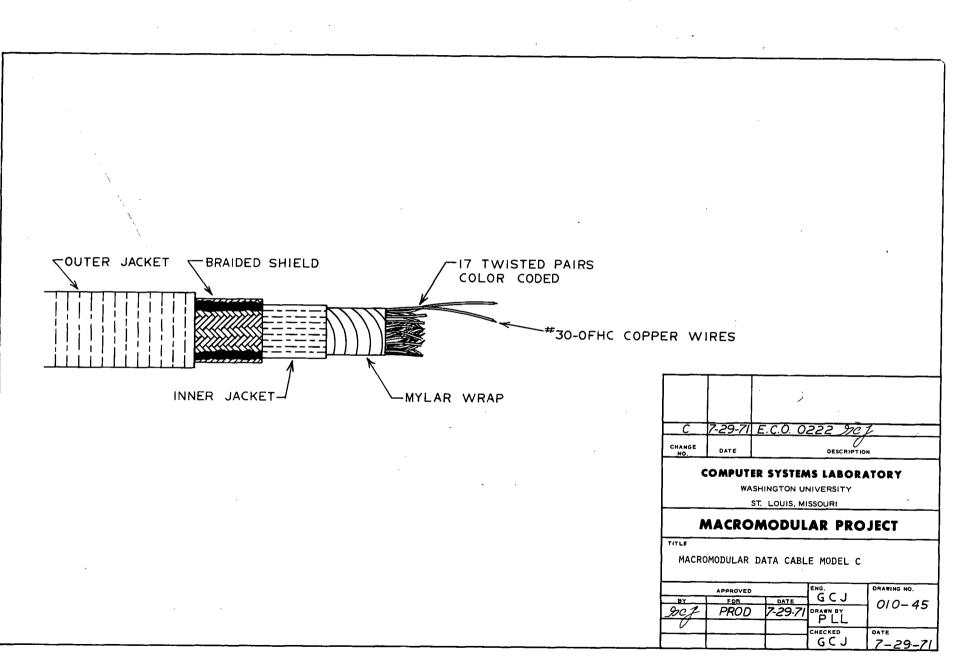
OUTER JACKET:

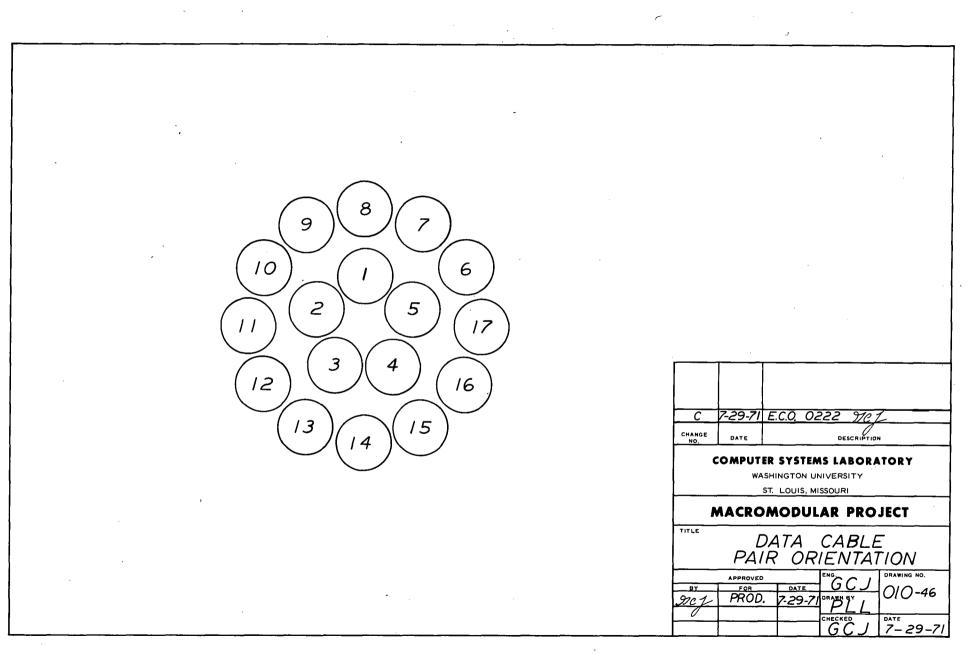
The cable shall be finished with an extruded soft PVC jacket.

MATERIAL: PVC (similar to Geon 8806 black) WALL THICKNESS NOMINAL: 0.030 inches WALL THICKNESS MINIMUM: 0.025 inches WALL THICKNESS MAXIMUM: 0.035 inches COLOR: chrome grey MANUFACTURING:

The outside surface of the cable shall be smooth and bear no brand or model markings. The maximum outside diameter of the completed cable shall be 0.312 inches. The minimum acceptable length for shipping is 100 feet. A sketch of the completed cable is shown on Drawing 010-45.

The completed cable shall be put up on large diameter spools with a low winding tension to insure maintenance of a round shape.





#### MACROMODULAR CONTROL CABLE SPECIFICATION CAS-7

## Introduction:

This specification gives an electrical and mechanical description of the Macromodular Control Cable. This cable will be used to transmit high speed digital control information between modular computer assemblies.

# General Specifications:

The cable described here shall conform to quality and workmanship standards such as those outlined in Brand Rex Commerical Specification BR-212C, November 1966.

#### Mechanical Description:

The cable is a two conductor, twisted pair, shielded cable similar to CAS-4 with a stronger shield.

2 Components - F03013 SPCWLD - Solid Colors (Conductor #30 Solid - Annealed - Silver Plated Copperweld - .010" O.D.) (Insulation - .013" Nom. Wall FEP - Colors Natural and Yellow)

2 Components Twisted @ 1.0" L.H. Lay - .072" O.D. Shield Jacket - #34 T/C - 90% Coverage Jacket PVC -.035" Nom. Wall - Color Black - .160" + .010 O.D.

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010-47

Electricals: DC-R 0.263 OHMS/FT @ 68° F Mutual Capacitance - 25 MMF/FT Impedance 120 OHMS ± 10% Conductivity - 40% 55,000PSI Min. 8% Elongation - Min.

Random Lengths - 100 Ft. Min.

The outside diameter is constrained by the connector to be 0.160  $\pm$  0.010 inches. The outside jacket is to be black, pressure molded PVC with no brand markings.

#### Electrical Description:

The major electrical requirement is that the balanced impedance between the inner conductors shall be 120 ohms. The characteristic impedance will meet the following limits:

Maximum Z<sub>O</sub> 132 ohm Nominal Z<sub>O</sub> 120 ohm Minimum Z<sub>O</sub> 110 ohm

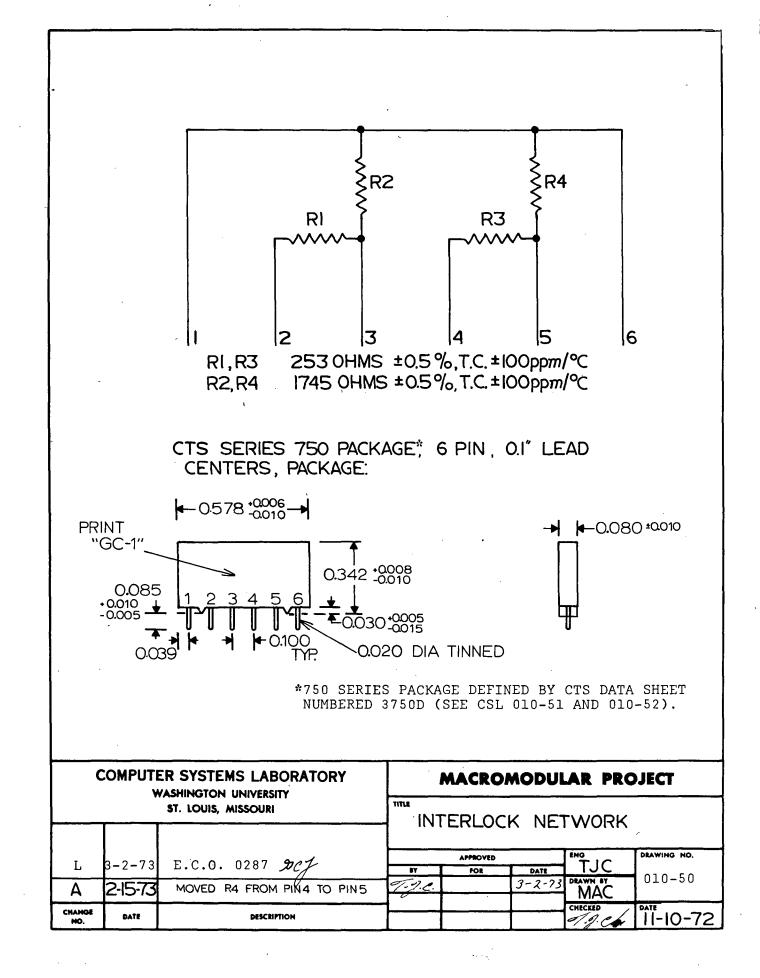
The manufacturer shall adjust the internal dimensions to achieve the specified impedance.

| сне. | E.C.O. | DATE    | APPR. |
|------|--------|---------|-------|
| Н    | 0246   | 1-11-72 | DC1   |
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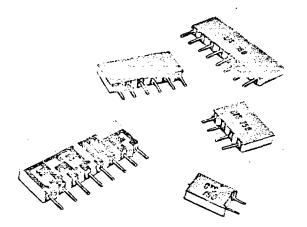
# INTERLOCK NETWORK

This resistor network is used in the interlock module to provide the offset voltages necessary to detect the metastable condition of the arbitrating latch.

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|------|--------|--------|-------|
| L    | 0287   | 3-3-73 | DCZ   |
|      |        |        | 0     |
|      |        |        |       |
|      |        |        |       |
|      |        |        |       |



CTS series 750 cermet resistor networks



electrical and mechanical specifications

| Resistance | Range: |
|------------|--------|
|------------|--------|

| Standard | - 50 ohms through    |    |
|----------|----------------------|----|
|          | 100K ohms            | ,  |
| Special  | - 10 ohms to 50 ohms | 3  |
|          | and above 100K ohr   | ns |
|          | through 1 megohm     |    |

Resistance Tolerance: Standard -  $\pm 5\%$ Special - to  $\pm 0.5\%$  Temperature Coefficient: Standard - +250 ppm/°C Special - to +100 ppm/°C

Resistor Material: Cermet - thick film

Lead Strength: 5# pull

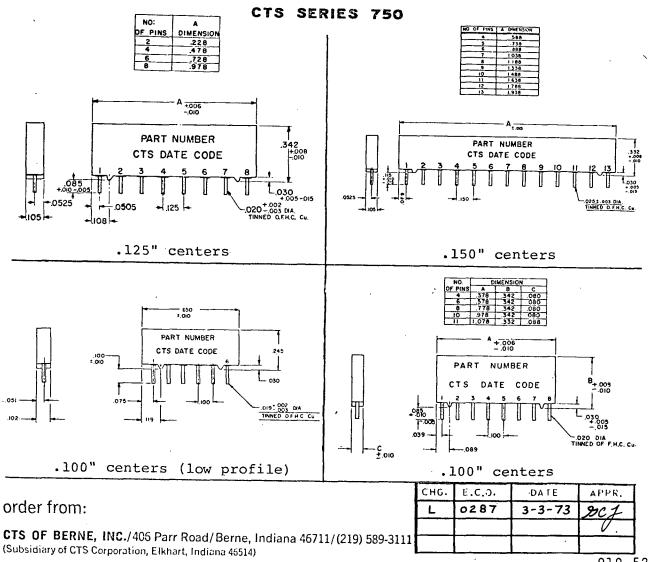
| Power Rat<br>Module |     |     |     |     |     |       |       |     |         |     |     |
|---------------------|-----|-----|-----|-----|-----|-------|-------|-----|---------|-----|-----|
| Lead                |     |     |     |     | Num | ber o | f Pin | 5   | <u></u> |     |     |
| Centers             | 2   | 4   | 5   | 6   | 7   | 8     | 9     | 10  | 11.     | 12  | 13  |
| .100"               | -   | .7  | -   | 1.0 | -   | 1.3   | -     | 2.0 | 2.3     | -   |     |
| .125"               | • 5 | 1.0 | ~   | 1.5 | -   | 2.0   | -     | -   | · _     | -   | -   |
| .150"               | -   | 1.3 | 1.7 | 2.0 | 2.3 | 2.6   | 3.0   | 3.3 | 3.6     | 4.0 | 4.3 |

DATA SHEET 3750D

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| L    | 0287   | 3-3-73 | DC1   |
|      |        |        |       |
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|      |        |        |       |

# ENVIRONMENTAL PERFORMANCE CHARACTERISTICS

| TEST   | Allowable Res<br>CTS Max. AR | Sistance Change<br>CTS Avg. AR |
|--|------------------------------|--------------------------------|
| SHORT TIME OVERLOAD: 2.5 times rated voltage, 5 sec.                           | <u>+</u> 0.25%               |                                |
| LOW TEMPERATURE EXPOSURE: -63°C, 4 hrs.  | +0.10%                       | <u>+</u> 0.04%                 |
| TERMINAL STRENGTH: 5 lb. tensile & compression, 30 sec.                        | <u>+</u> 0.10%               | <u>+</u> 0.03%                 |
| EFFECT OF SOLDERING: 63/37 solder,<br>246°C, 2 sec.                            | +0.10%                       | <u>+</u> 0.05%                 |
| LOAD LIFE: 0.1 watt per resistor at 70°C, 1000 hrs.                            | +0.40%                       | <u>+</u> 0.20%                 |
| MOISTURE RESISTANCE: .1 rated wattage at 70°C, 90-98% humidity, 1000 hrs.      | <u>+</u> 0.50%               | <u>+</u> 0.20%                 |
| INSULATION RESISTANCE: Measured wet after<br>moisture resistance test, 200 VDC | 500 me                       | gohm                           |
| THERMAL SHOCK: 5 cycles, -63°C to<br>+125°C, no load                           | <u>+</u> 0.10%               | <u>+</u> 0.03%                 |



010-52

t

# Multi-Layer P.C. Board Specification PC-2

#### I. Scope:

This document provides general specifications for multi-layer printed circuit boards with solder plated plated-through holes for use in macromodule subassemblies. These general specifications apply to all multi-layer circuit board types <u>unless</u> <u>specific exception is made</u> within the documents describing a particular circuit board type.

II. Material:

Material is to be type FR-4. Thickness of finished boards is to be as shown in Figures 1 and 2.

#### III. Plating:

Finished thickness of copper on conductors, pads and terminal areas shall be from 0.002 to 0.003 inches. Thickness in holes is given below. A layer of leadtin alloy shall be plated to a depth of 0.0003 to 0.0007 over all copper surfaces. All circuit boards shall have the solder plating on both surfaces reflowed by means of a hot peanut oil, hydro-squeegee, or similar process in order to melt back plating overhang. Final plated surface shall be free of contamination and shall be free from defects that may be detrimental to good soldering.

When areas of gold plating are specified (such as contact fingers) there shall be a minimum of 0.000050 inches of gold over a minimum of 0.000150 inches of nickel. The gold shall be free of porosity or nodules.

## IV. Etching:

Areas not intended to have conductor shall be etched free of any copper residue. Undercutting should not exceed copper thickness. Undercutting should not produce splinters along conductor edges.

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#### V. Dimensional tolerances on final etch pattern:

A. Conductor paths corresponding to 0.040 tape in the 4:1 artwork shall have a minimum width of 0.008 inch and a maximum width of 0.012 inch. Width as narrow as 0.005 inch is acceptable for a distance not exceeding 0.020 inch along a line, but not in the area where a line joins a pad. No more than five such narrowings are allowable on one surface of any circuit board.

B. Width greater than 0.012 inch shall be acceptable if minimum clearances are maintained between conducting paths and providing that no more than 10% of the length of a given line exceeds a width of 0.012 inch.

C. A minimum clearance of 0.007 inch between adjacent conducting areas shall be maintained.

VI. Plated-through holes:

A. One plated-through hole type is generally used. Additional platedthrough and non-plated-through hole types may be specified for individual board designs.

1. Type "1" holes are plated through with a finished diameter after copper and solder plating of .033 to .038.

B. Holes should be plated through unless otherwise specified. Finished Plating thickness of copper on the wall of the hole shall be a minimum average of 0.001 inch as measured at three points at least 0.010 inches apart. No single measurements shall be less than 70% of this minimum. Pinholes, voids, pits and projections are excluded from these measurements.

C. No more than three voids per hole are permitted. Total area of the voids shall not exceed 10% of the total wall area. Largest dimension not to exceed 25% of the core circumference or 25% of the thickness of the board.

D. No plated hole shall have voids or pits at the junction of the hole wall and terminal area to a depth of 1-1/2 times the total copper thickness on the surface.

E. A minimum annular ring of .005 inches must be maintained around each hole for external layers.

F. Hole diameter tolerances given apply prior to the reflow operation. Reduction of hole diameter of 15 percent or less during reflow is acceptable.

#### VII. Unplated holes:

Registration and reference holes are not plated through, and generally are 0.093 + or - 0.003 inches unless otherwise shown on individual board documents. Additional types may be specified for individual board designs.

## VIII. Hole positioning:

A. All holes are to be registered to within  $\pm$  0.005 inches of true position with respect to other holes.

#### IX. Artwork:

A. Artwork for circuit boards is prepared as follows: Master Pad Patterns are taped at 4:1 on 7 mil mylar on an etched glass grid plate with 0.050 spacing between grid lines. Cronaflex prints made from the Master Pad Pattern are used for taping the artwork for both sides of the circuit board to ensure registration.

B. Minimum clearance of 0.045 is maintained between taped regions that are not in contact. This minimum clearance generally occurs only at the nearest approach of a printed circuit line to a pad.

C. Minimum pad size of 0.250 inch O.D.

D. Pads used for clearance on inner layer will be enlarged to .340 inch
0.D.

E. No conducting paths are taped with tape less than 0.040 inches wide.

F. Artwork is generally supplied in the form of 4:1 Cronaflex contact prints of the taped artwork. The Cronaflex print may contain small amounts of tape used for adjustments or corrections. These Cronaflex prints should be returned to Washington University following their use in preparing reductions.

# X. Artwork Identification:

All artwork is identified by a number appearing on the artwork within the region that will be reproduced on the circuit board, Artwork for each layer of a circuit board bears a number, typically in the form XXX NNN-N, where X designates letters A through Z and N designates numbers 0 through 9. All letters and numbers of this group are significant and should correspond exactly on the

artwork for each of the layers of a specific board. Two additional characters will follow the above identifying number. They are used to specify the artwork of the layers. The designations L1, L2, L3, L4, specify the artwork orientation as shown in Figures 1 and 2.

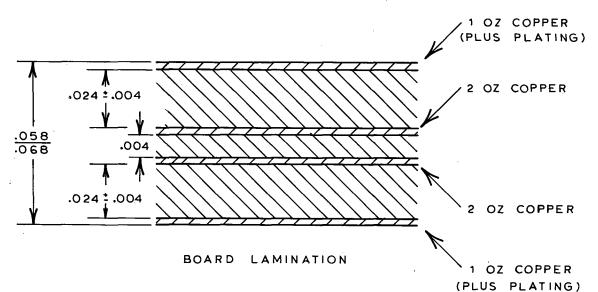
#### XI. Board finish:

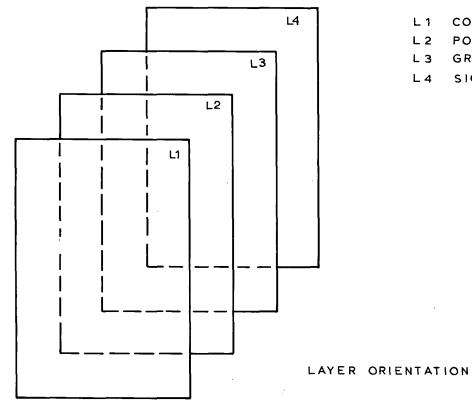
When specified, the component side of the circuit board will have a screened pattern for component identification applied. The material applied shall be non-conductive, permanent, and resistant to materials and procedures used in board assembly, inspection, and cleaning.

Delivered circuit boards shall be free of scratches, abrasions, other physical damage, and contamination by foreign substances or residues. Any damage that exposes copper underlying solder plating is cause for board rejection.

XII. Board packaging:

Circuit boards shall be shipped in individual plastic covers to prevent contact between the surfaces of adjoining circuit boards and to protect board from abrasion. They shall be secured so as to prevent slipping against one another during shipment.





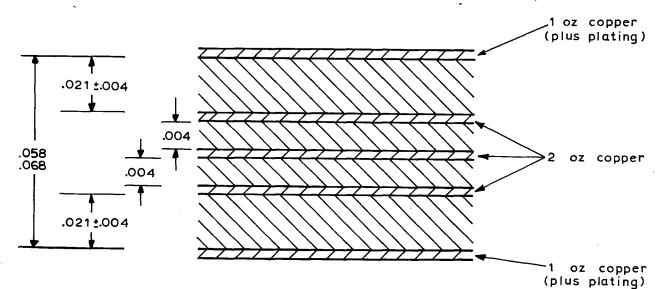
L1 COMPONENT

POWER

GROUND

SIGNAL

FIGURE 1 4 LAYER BOARD CONSTRUCTION





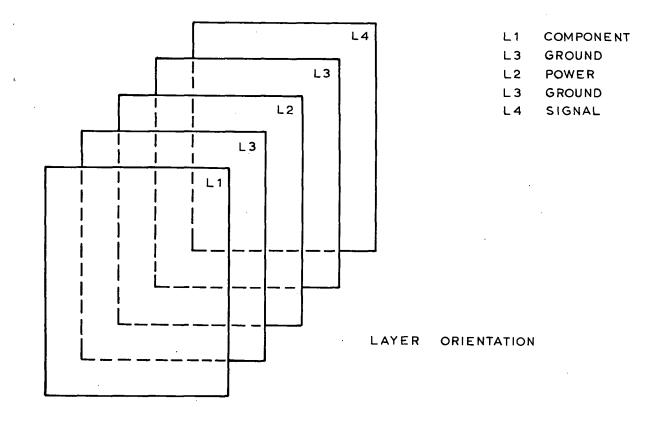


FIGURE 2 5 LAYER BOARD CONSTRUCTION **COMPUTER SYSTEMS LABORATORY** 

WASHINGTON UNIVERSITY



# SYSTEM MAINTENANCE

| PAGE                     | TITLE   | CHANGE   |
|--------------------------|---|----------|
| 012-1                    | TITLE PAGE  | D        |
| 012-2                    | TITLE PAGE (cont)   |          |
| 012-3                    | INTRODUCTION  |          |
| 012-4                    | REAR CONNECTOR  |          |
| 012-5                    | TYPE I FACEPLATE SUB SUBASSEMBLY                              |          |
| 012-5                    |   |          |
| thru                     | TYPE 1 WIRING LIST (LOGIC, ADDITION, SHIFT, LOAD AND COMPARE) | A C      |
| 012-12                   |   |          |
| 012-13                   | TYPE 2 FACEPLATE SUB SUBASSEMBLY                              | 1        |
| 012-13A                  | TYPE 2 TO MERGE OR CALL MAP                                   | В        |
| 012–14<br>thru<br>012–20 | TYPE 2 WIRING LIST (DECISION CALL)                            | Â        |
| 012-21                   |   |          |
| thru                     | TYPE 2 WIRING LIST (MERGE/RENDEZVOUS BRANCH)                  |          |
| 012-27                   |   |          |
| 012-28                   | TYPE 3 FACEPLATE SUB SUBASSEMBLY                              |          |
| 012-29                   |   |          |
| thru                     | TYPE 3 WIRING LIST (REGISTER)                                 | <i>`</i> |
| 012-35                   |   |          |
| 012-35                   | TYPE 4 FACEPLATE SUB SUBASSEMBLY                              |          |
| 012-37                   |   |          |
| thru                     | TYPE 4 WIRING LIST (DECODER)                                  | `        |
| 012-42                   |   |          |
| 012-43                   | TYPE 5 FACEPLATE SUB SUBASSEMBLY                              |          |
| 012-44                   |   | · · ·    |
| thru                     | TYPE 5 WIRING LIST (DATA BRANCH)                              |          |
| 012-52                   |   |          |
| 012-53                   | TYPE 6 FACEPLATE SUB SUBASSEMBLY                              |          |
| 012-54                   |   |          |
| thru                     | TYPE & WIRING LIST (DIGITAL TO ANALOG D/A)                    |          |
| 012-57                   | · · ·   |          |
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| A     | 0229   | 11-16-71 | RSA  |     |        |      |      |      |        |      |       |
| В     | 0233   | 11-24-71 | MXP  |     |        |      |      |      |        |      |       |
| С     | 0247   |          | RJA  |     |        |      |      |      |        |      |       |
| D     | 0286   | 3-22-73  | 91C7 |     |        |      |      |      |        |      |       |

MACROMODULAR SYSTEMS PROJECT

5

# SYSTEM MAINTENANCE

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| PAGE   | TITLE  | CHANGE |
|--------|--|--------|
| 012-58 | Pin Assignments Fan-Center Channel Connector | D      |
| 012-59 | Pin Assignments Lateral Channel to Module    | D      |
| 012-60 | Lateral Channel Connector Numbering          | D      |
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MACROMODULAR SYSTEMS PROJECT

#### INTRODUCTION

This is a collection of documents which should aid in tracing wiring paths through Faceplate Boxes. Each of the Faceplate Boxe types is represented by a wiring list on which all connections are given their logic names and wire colors. A picture of the rear connectors is included here for convenience, and a picture of the front panel of each type of Faceplate Box immediately precedes the corresponding wiring list.

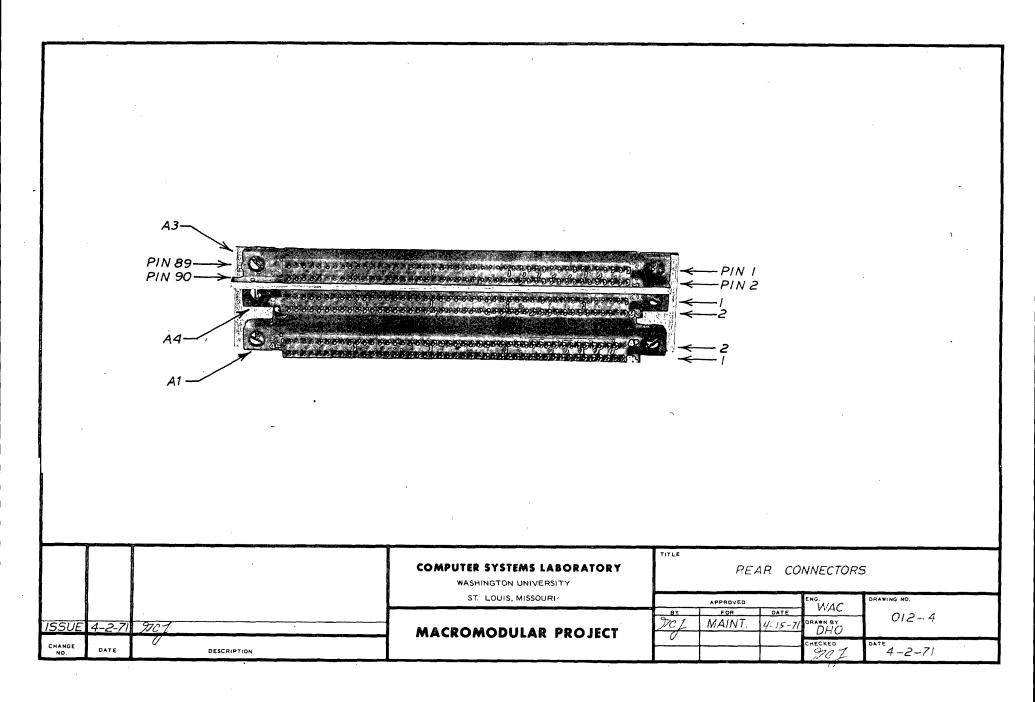
When probing with an ohm meter - PLEASE USE GOLD CON-TACTS. An appropriate mating contact should always be inserted, rather than a probe tip or copper wire.

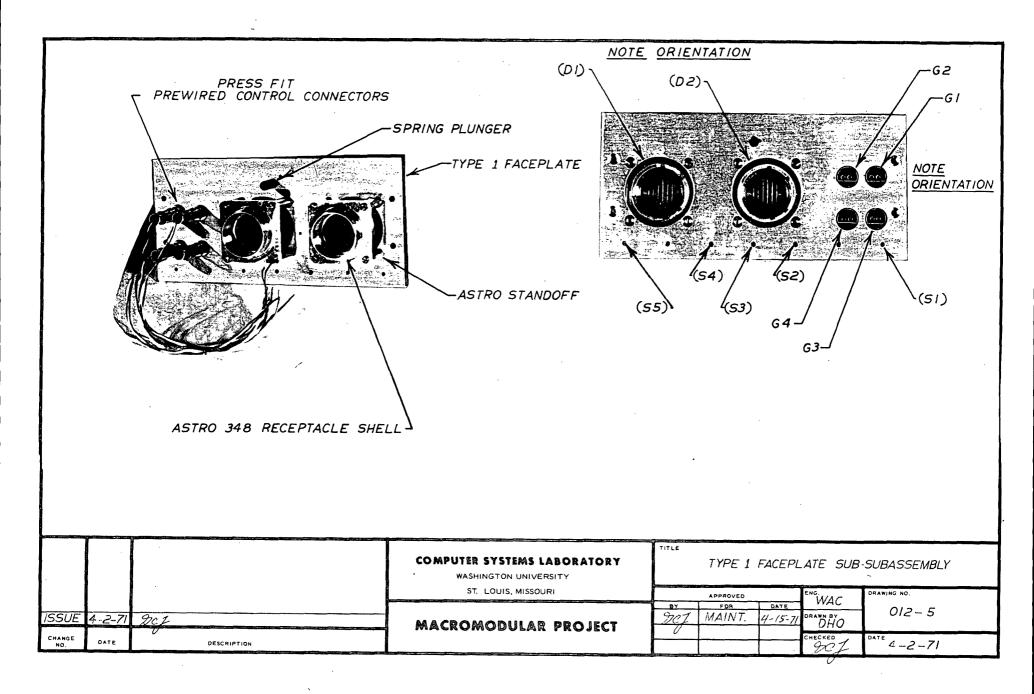
For Astro-348 Connectors, use the loose piece male or female contact. For the Blue Amp Box Connectors, use an AMP-MODU male pin. Control connectors require the use of an ohm meter probe tip - but be sure the tip touches only the outer portion of the contact.

Refer to other Faceplate Box documents (300 series) for information not contained here.

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#### FPT1NC,1 LN=1

[TYPE ONE FACEPLATE BOX WIRING LIST E # 1A3 [GROUND [NO CONNECTION # 2A3 [GROUND [NO CONNECTION # 3A3 [MASK3 L FF 24D1 [BIT 3 L [ ORANGE # 4A3 [MASK3 H FF 23D1 [BIT 3 H [ RED # 5A3 [MASK2 L FF 33D1 [BIT 2 L [ BLUE # 6A3 [MASK2 H FF 32D1 [BIT 2 H [ RED # 7A3 [MASK1 L FF 31 D1 [BIT 1 L [ SLATE # 8A3 [MASK1 H FF 30D1 [BIT 1 H [ YELLOW # 9A3 [MASKO L FF 37D1 [BIT ZERO L [ ORANGE # 10A3 [MASKO H FF 36D1 [BIT ZERO H [ YELLOW # 11A3 [ARG3 L FF 24D2 [BIT 3 L [ ORANGE # 12A3 [ARG3 H FF 23D2 [BIT 3 H [ RED # 13A3 [ARG2 L FF 33D2 [BIT 2 L [ BLUE # 14A3 [ARG2 H FF 32D2 [BIT 2 H [ RED # 15A3 [ARG1 L FF 31 D2 [BIT 1 L [ SLATE #

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16A3 [ARG1 H FF 30D2 BIT 1 H [ YELLOW # 17A3 [ARGO L FF 37D2 BIT ZERO L [ ORANGE # 18A3 [ARGO H FF 36D2 [BIT ZERO H [ YELLOW # 19A3 [GROUND 22D1 [GROUND [ BLUE # 20A3 [GROUND 22D2 GROUND [ BLUE # 21A3 [MASK7 L FF 21D1 [BIT 7 L [ BROWN # 22A3 [MASK7 H FF 20D1 BIT 7 H [ YELLOW # 23A3 MASK6 L FF 17D1 [BIT 6 L [ GREEN # 24A3 [MASK6 H FF 16D1 [BIT 6 H [ YELLOW # 25A3 [MASK5 L FF 28D1 BIT 5 L SLATE # 26A3 [MASK5 H FF 27D1 [BIT 5 H [ WHITE # 27A3 [MASK4 L FF 26D1 BIT 4 L BROWN # 28A3 [MASK4 H FF 25D1 BIT 4 H RED # 29A3 [ARG7 L FF 21D2 [BIT 7 L [ BROWN # 30A3 [ARG7 H FF 20D2 [BIT 7 H [ YELLOW 31A3 [ARG6 L FF 17D2 BIT 6 L GREEN

012-7

32A3 [ARG6 H FF 16D2 [BIT 6 H [ YELLOW # 33A3 [ARG5 L FF 28D2 [BIT 5 L [ SLATE # 34A3 [ARG5 H FF 27D2 [BIT 5 H [ WHITE # 35A3 [ARG4 L FF 26D2 [BIT 4 L [ BROWN # 36A3 [ARG4 H FF 25D2 [BIT 4 H [ RED . # 37A3 [GROUND 3G1 [ GROUND [ BLUE # 38A3 [GROUND 3G2 [ GROUND [ BLUE # 39A3 [MASK11 L FF 9D1 [BIT 11 L [ ORANGE # 40A3 [MASK11 H FF 8D1 [BIT 11 H [ WHITE # 41A3 MASK10 L FF 15D1 [BIT 10 L [ GREEN # 42A3 MASK10 H FF 14D1 [BIT 10 H [ RED # 43A3 [MASK9 L FF 13D1 BIT 9 L GREEN # 44A3 [MASK9 H FF 12D1 [BIT 9 H [ WHITE # 45A3 [MASK8 L FF 11D1 [BIT 8 L [ BROWN # 46A3 [MASK8 H FF 10D1 [BIT 8 H [ WHITE # 47A3 [ARG11 L FF 9D2 [BIT 11 L [ ORANGE #

012-8

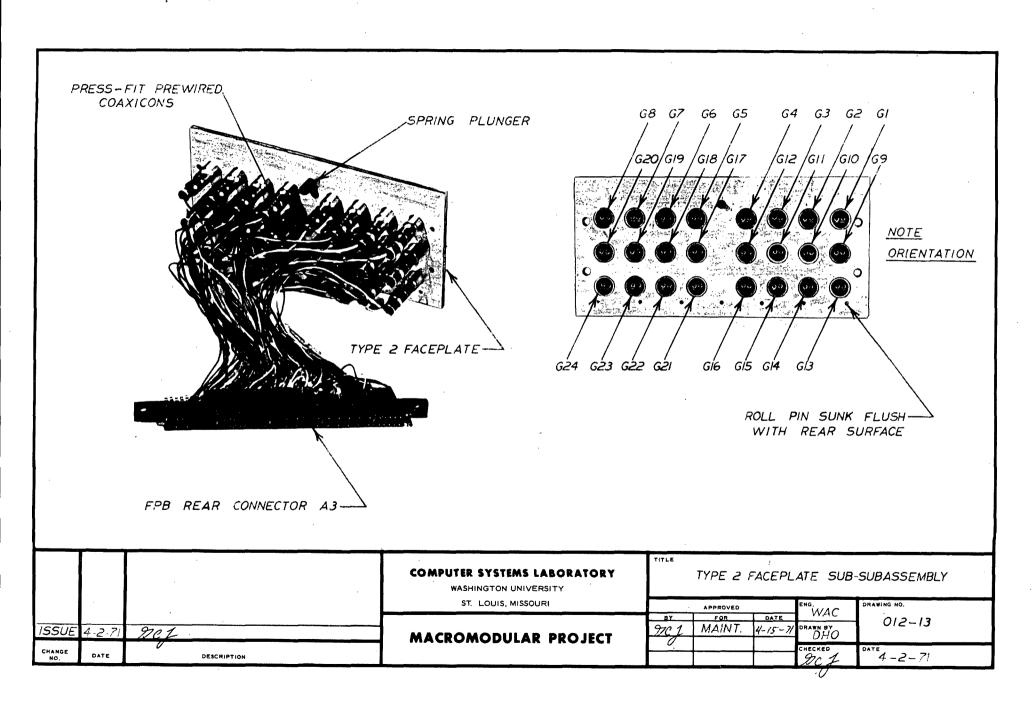
48A3 [ARG11 H FF 8D2 [BIT 11 H [ WHITE # 49A3 [ARG10 L FF 15D2 [BIT 10 L [ GREEN # 50A3 [ARG10 H FF 14D2 [BIT 10 H [ RED # 51A3 [GROUND 3G3 [ GROUND [ BLUE # 52A3 [GROUND 3G4 [ GROUND [ BLUE # 53A3 [ARG9 L FF 13D2 [BIT 9 L [ GREEN # 54A3 [ARG9 H FF 12D2 [BIT 9 H [ WHITE # 55A3 [ARG8 L FF 11D2 BIT 8 L BROWN # 56A3 [ARG8 H FF 10D2 [BIT 8 H [ WHITE # 57A3 [C1 H TF 1G3 [ CONTROL HIGH [ WHITE # 58A3 [C1 L TF 2G3 [ CONTROL LOW [ GREEN # 59A3 [C2 H TF 1G4 [ CONTROL HIGH [ WHITE # 60A3 [C2 L TF 2G4 [ CONTROL LOW [ BROWN # 61A3 [DDR ARG H TF 18D2 [ DD RETURN H [ VIOLET · # 62A3 [DDR ARG L TF 19D2 [ DD RETURN L [ BLUE # 63A3 [DDR MASK H TF 18D1 DD RETURN H VIOLET

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64A3 [DDR MASK L TF 19D1 [ DD RETURN L [ BLUE # 65A3 [GROUND INO CONNECTION # 66A3 [GROUND [NO CONNECTION # 67A3 [12 H FF 1G2 [ CONTROL HIGH [ WHITE # 68A3 [12 L FF 2G2 [ CONTROL LOW [ ORANGE # 69A3 [11 H FF 1G1 [ CONTROL HIGH [ WHITE # 70A3 [11 L FF 2G1 [ CONTROL LOW [ BLUE # 71A3 [DD MASK H FF 6D1 [ D DELIVER H [ VIOLET # 72A3 [DD MASK L FF 7D1 [ D DELIVER L [ ORANGE # 73A3 [DD ARG H FF 6D2 [ D DELIVER H [ VIOLET # 74A3 [DD ARG L FF 7D2 [ D DELIVER L [ ORANGE # 75A3 [NO CONNECTION 29D2 [CABLE SENSE [ GREEN # 76A3 [NO CONNECTION 29D1 [CABLE SENSE [ GREEN # ĺ TWO WIRES ARE SOLDERED TO PIN 77A3 77A3 [POWER 5D1 [POWER [ YELLOW 5D2 [POWER [ YELLOW # 78A3 [GROUND [ SIX INCH BLUE WIRE WITH GROUND LUG [CONNECT TO D1 # 

[ ONE WIRE TO PIN 79A3 AND TWO WIRE CONNECTIONS ON EACH COMMON PIN OF THE SWITCHES 79A3 [CODE DRIVER H TF 1S1 [ COMMON [YELLOW 1S2 COMMON [YELLOW 1S3 [ COMMON [YELLOW 1S4 [ COMMON [YELLOW 1 S5 COMMON YELLOW # Γ 80A3 [GROUND [ SIX INCH BLUE WIRE WITH GROUND LUG [CONNECT TO D2 81A3 [RMB H F.F 2S1 [ NORMAL CLOSED [RED 82A3 [GROUND [NO CONNECTION # 83A3 [FN3 L FF 2S5 [ NORMAL CLOSED [RED # 84A3 [GROUND NO CONNECTION 85A3 [FN2 L FF 2S4 [ NORMAL CLOSED [RED # 86A3 [GROUND [NO CONNECTION # 87A3 [FN1 L FF 2S3 [ NORMAL CLOSED [RED # 88A3 [GROUND **INO CONNECTION** # 89A3 [FNO L FF 2S2 [ NORMAL CLOSED [RED 90A3 [GROUND [NO CONNECTION # THE FOLLOWING CONNECTIONS ARE RESISTORS WITH THEIR LEADS CRIMPED DIRECTLY INTO THE INDICATED CONNECTOR CONTACTS. THE EXPOSED PORTION OF THE LEADS SHALL BE COVERED BY TEFLON SLEEVING. THE COLOR CODE MAY BE IGNORED. ſ 1D1 [SPARE 1 [ RED 1R601 [ 130 OHM RESISTOR # 2D1 [SPARE 2 [ SLATE CHG. E.C.O. DATE APPR. 2R601 [ 130 OHM RESISTOR 0229 11/16/7 Α RJA # С 0247 RJA1-13-72 1D2 [SPARE 1 [ RED 1R602 [ 130 OHM RESISTOR # 2D2 [SPARE 2 [ SLATE 2R602 [ 130 OHM RESISTOR

# 3D1 [SPARE 3 [ YELLOW 1R603 [ 130 OHM RESISTOR # 4D1 [SPARE 4 [ BLUE 2R603 [ 130 OHM RESISTOR # 3D2 [SPARE 3 [ YELLOW 1R604 [ 130 OHM RESISTOR # 4D2 [SPARE 4 [ BLUE 2R604 [ 130 OHM RESISTOR # 34D1 [SPARE 5 [ WHITE 1R605 [ 130 OHM RESISTOR # 35D1 [SPARE 6 [ BLUE 2R605 [ 130 OHM RESISTOR # 34D2 [SPARE 5 [ WHITE 1R606 [ 130 OHM RESISTOR # 35D2 [SPARE 6 [ BLUE 2R606 [ 130 OHM RESISTOR # [END OF CONNECTION LIST [FACEPLATE TYPE ONE COPPER LIST [FPT1NC [GERALD C JOHNS [29 SEPT 1970



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- Map from Type II faceplate box (G1-G24), through PTF0091-1 motherboard (A3), to vertical boards (F1, F3, F5).
- USE: to track a failure from a known faceplate location (G\_) to the corresponding AMP-MODU on a logic drawing.

#### EXAMPLE:

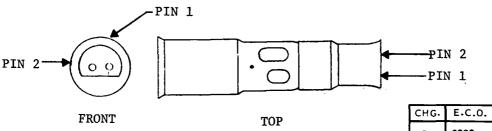
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1G15-59A3-5F5 HIGH 2G15-60A3-4F5 LOW POLARITY FOR PRESET

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#### COAXICON PIN DESIGNATION



| CHG. | E.C.O. | DATE     | APPR. |
|------|--------|----------|-------|
| В    | 0233   | 11-24-71 | IMLP  |
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012-13A

012–14

| -      | RING              | LIST                             | FOR TYPE                               | TWO | FACEPLATE | вох |
|--------|-------------------|----------------------------------|--|-----|-----------|-----|
|        |                   |                                  |  |     |           |     |
| L<br># | >>>>              | »>>>>>                           | »>>>>>                                 |     |           |     |
| π<br># | 1A3<br>3G7<br>3G8 | [GRC]<br>BLUE<br>BLUE            | 2                                      |     | ,         |     |
| #      | 2A3<br>3G19       | >>>>>><br>[GRC<br>[ BLU<br>[ BLU | Æ                                      | ×   |           |     |
| #      | 3A 3              | >>>>>><br>[YA<br>[ YEI           |  |     |           |     |
| #      | 2G24              | [YA<br>[ GRE                     | EEN                                    |     |           |     |
| #      | 5A3               |                                  | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>> |     |           |     |
| # .    |                   | [¥1#<br>[ OR#                    | ALTF<br>ANGE                           |     |           | ٠   |
|        |                   | [NA                              |  |     |           |     |
| #      | 8A3<br>2G20       | [NA<br>[BRC                      | L FF<br>DWN                            |     |           |     |
| "      | 9A3               | _                                | >>>>>><br>. H TF<br>)                  |     |           |     |
| #      | 10A3<br>2G19      | [N1A<br>[ GRE                    | L TF<br>EN                             |     |           |     |
| #      | 11A3              |                                  | >>>>>><br>A TF<br>LOW                  |     |           |     |
| #      |                   | [Y2A<br>[ BLU                    | L TF<br>JE                             |     |           |     |
| #      | 1 3A 3            |                                  | >>>>>><br>H TF                         |     |           |     |
| "      |                   |                                  |  |     |           |     |

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FPT2NC,1 LN=1

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15A3 [N2A H TF 1G18 [ RED # 16A3 [N2A L TF 2G18 [ORANGE # 17A3 [N3A H TF 1G17 [ RED # 18A3 [N3A L TF 2G17 [ BLUE # 19A3 [GROUND 3G23 [ BLUE 3G24 [ BLUE # 20A3 [GROUND 3G5 [ BLUE 3G6 [ BLUE # 21A3 [NO CONNECTION [NO CONNECTION # 22A3 [NO CONNECTION [NO CONNECTION # 23A3 [NO CONNECTION [NO CONNECTION 24A3 [NO CONNECTION [NO CONNECTION 25A3 [NO CONNECTION [NO CONNECTION # 26A3 [NO CONNECTION [NO CONNECTION # 27A3 [NO CONNECTION [NO CONNECTION 28A3 [NO CONNECTION [NO CONNECTION # [NO CONNECTION [NO CONNECTION 29A3 , # 30A3 [NO CONNECTION [NO CONNECTION # 31A3 [NO CONNECTION [NO CONNECTION # 32A3 [NO CONNECTION [NO CONNECTION # 33A3 [DA H TF 1G8 [ YELLOW

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34A3 [DA L TF

14A3 [Y3A L TF 2G21 [ SLATE

### FPT2NC,3 LN=163

2G8 [ GREEN

012-16

# 35A3 [I1A H FF 1G7 [ YELLOW # 36A3 [11A L FF 2G7 [ ORANGE 37A3 [GROUND 3G17 [ BLUE 3G18 [ BLUE # 38A3 [GROUND 3G21 [ BLUE 3G22 BLUE # 39A3 [DB H TF 1G4 [ CONTROL HIGH [ WHITE # 40A3 [DB L TF 2G4 [ CONTROL LOW [ BROWN # 41A3 [I1B H FF 1G3 [ CONTROL HIGH [ WHITE `# 42A3 [11B L FF 2G3 [ CONTROL LOW [ GREEN # 43A3 [I2A H FF 1G6 [ YELLOW # 44A3 [12A L FF 2G6 [ BLUE # 45A3 [I3A H FF 1G5 [ WHITE # 46A3 [I3A L FF 2G5 [ SLATE # 47A3 [12B H FF 1G2 [ CONTROL HIGH [ WHITE # 48A3 [12B L FF 2G2 [ CONTROL LOW [ ORANGE , # 49A3 [I3B H FF 1G1 [ CONTROL HIGH [ WHITE

# 50A3 [I3B L FF 2G1 [ CONTROL LOW [ BLUE # 51A3 [GROUND 3G3 [ GROUND [ BLUE 3G4 [ GROUND [ BLUE # 52A3 [GROUND 3G11 [ BLUE 3G12 [ BLUE # 53A3 [NO CONNECTION [NO CONNECTION # 54A3 [NO CONNECTION [NO CONNECTION # 55A3 [NO CONNECTION [NO CONNECTION # 56A3 [NO CONNECTION [NO CONNECTION # 57A3 [YB H FF 1G16 [ YELLOW # 58A3 [YB L FF 2G16 [ GREEN # 59A3 [Y1B H TF 1G15 [ YELLOW # 60A3 [Y1B L TF 2G15 [ ORANGE # 61A3 [NB H FF 1G12 [ RED # 62A3 [NB L FF 2G12 BROWN # 63A3 [N1B H TF 1G11 [ RED # 64A3 [N1B L TF 2G11 [ GREEN # 65A3 [GROUND 3G15 [ BLUE 3G16 [ BLUE # 

# FPT2NC,5 LN=345

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| #  | 66A3 [GROUND<br>3G1 [ GROUND [ BLUE<br>3G2 [ GROUND [ BLUE |
|----|--|
|    | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>                      |
| #  | 68A3 [Y2B L TF<br>2G14 [ BLUE                              |
| π  | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>                     |
| #  | 70A3 [Y3B L TF<br>2G13 [ SLATE                             |
| #  | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>                     |
| #  | 72A3 [N2B L TF<br>2G10 [ ORANGE                            |
| #  | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>                     |
| #  | 74A3 [N3B L TF<br>2G9 [ BLUE                               |
| #  | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>                     |
| #  | 76A3 [NO CONNECTION [NO CONNECTION                         |
| 11 | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>                     |
| #  | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>                     |
| #  | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>                     |
| #  | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>                     |
| #  | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>                     |

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## FPT2NC,6 LN=436

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| 82A3 [GROUND [NO CONNECTION   |
|---|
| # 83A3 [NO CONNECTION [NO CONNECTION  |
| # 84A3 [GROUND [NO CONNECTION   |
| # 85A3 [NO CONNECTION [NO CONNECTION  |
| # 86A3 [GROUND [NO CONNECTION   |
| # 87A3 [NO CONNECTION [NO CONNECTION #  |
| 88A3 [GROUND [NO CONNECTION   |
| # 89A3 [NO CONNECTION [NO CONNECTION  |
| # 90A3 [GROUND [NO CONNECTION   |
| #<br>[<br>[   |
| L<br>[SWITCHES ARE WIRED WITH SINGLE WIRES  |
| 79A4 [NO CONNECTION   |
| #<br>80A4<br>2S1 [ NORMAL CLOSED [RED   |
| # 81A4 [NO CONNECTION   |
| #<br>82A4<br>2S2 [ NORMAL CLOSED [RED   |
| # 83A4 [NO CONNECTION   |
| #<br>84A4<br>2S3 [ NORMAL CLOSED [RED   |
| # 86A4 [NO CONNECTION   |
| # 87A4 [NO CONNECTION   |
| #<br>88A4<br>1S1 [ COMMON [YELLOW<br>1S2 [ COMMON [YELLOW<br>1S3 [ COMMON [YELLOW<br>#    |
| 89A4 [NO CONNECTION   |
| #<br>[<br>[<br>[END OF WIRING LIST<br>[<br>[<br>[<br>[<br>[<br>[FPT2NC<br>[GERALD C JOHNS |
|   |

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012–19

FPT2NC,7 LN=527

[26 MARCH 1971

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FPT2NCM,1 LN=1

| [FPT2C                     |   |     |
|----------------------------|---|-----|
| L<br>[WIRIN<br>[<br>[<br>[ | G LIST FOR TYPE TWO FACEPLATE           | BOX |
|                            | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>> |     |
| 3G<br>3G                   | 3 [GROUND<br>7 [ BLUE<br>8 [ BLUE       |     |
| 2A<br>3G                   | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>  |     |
|                            | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>  |     |
|                            | 3 [I2B L FF<br>24 [ GREEN               |     |
| >><br>5A<br>1G             | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>  |     |
| 20                         | 3 [I1B L FF<br>23 [ ORANGE              |     |
| 7A<br>1 G                  | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>  |     |
|                            | .3 [I2A L FF<br>20 [ BROWN              |     |
| >><br>91                   | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>  |     |
| 20                         | DA3 [I1A L FF<br>19 [ GREEN _           |     |
| 11<br>10                   | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>  |     |
|                            | A3 [C2B L TF<br>22 [ BLUE               |     |
| )<br>13                    | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>  |     |

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| ц | 14A3<br>2G21                     | [C1E<br>SLA  | 3 L<br>ATE        | TF       |     | ·.         |
|---|----------------------------------|--------------|-------------------|----------|-----|------------|
| # | >>>>><br>15A3<br>1G18            | [C2#         | A H               |          |     |            |
| # | 16A3                             | -            | L                 |          |     |            |
| # | >>>>>><br>17A3<br>1G17           | [C1A         | АН                |          |     |            |
| # | 18A3<br>2G17                     | -<br>[C1#    | \ L               | TF       |     |            |
| # | >>>>>><br>19A3<br>3G23  <br>3G24 | GRC]<br>BLU] | JUNI<br>JE        |          |     |            |
| # |                                  |              | D <b>UNI</b><br>E |          |     |            |
| # | >>>>><br>21A3                    |              |                   |          | [NO | CONNECTION |
| # | 22A3                             | [NO          | CO                | NNECTION | [NO | CONNECTION |
| # | 23A3                             | [NO          | CO                | NNECTION | [NO | CONNECTION |
| # | 24A3                             | [NO          | col               | NNECTION | [NO | CONNECTION |
| # | 2 5A 3                           | [NO          | co                | NNECTION | [NO | CONNECTION |
| # | 26A3                             | [NO          | CO                | NNECTION | [ио | CONNECTION |
| # | 27A3                             | [NO          | col               | NNECTION | [NO | CONNECTION |
| # | 28A3                             | [NO          | co                | NNECTION | [NO | CONNECTION |
| # | 29A3                             | [NO          | col               | NNECTION | [NO | CONNECTION |
| # | 30A3                             | [NO          | co                | NNECTION | [NO | CONNECTION |
| # | 31A3                             | [NO          | coi               | NNECTION | [NO | CONNECTION |
| # | 32A3                             | [NO          | col               | NNECTION | [NO | CONNECTION |
| # | >>>>>><br>33A3<br>1G8 [          | [121         | ЭН                |          |     |            |
| # | 34A3                             | [12]         | ) L               | FF       |     |            |
|   |                                  |              |                   |          |     |            |

012–23

2G8 [ GREEN # 35A3 [11D H FF 1G7 [ YELLOW # 36A3 [11D L FF 2G7 [ ORANGE # 37A3 [GROUND 3G17 [ BLUE 3G18 [ BLUE 38A3 [GROUND 3G21 [BLUE 3G22 [ BLUE # 39A3 [12C H FF 1G4 [ CONTROL HIGH [ WHITE 40A3 [I2C L FF 2G4 [ CONTROL LOW [ BROWN # 41A3 [I1C H FF 1G3 [ CONTROL HIGH [ WHITE # 42A3 [11C L FF 2G3 [ CONTROL LOW [ GREEN # 43A3 [C2D H TF 1G6 [ YELLOW # 44A3 [C2D L TF 2G6 [ BLUE # 45A3 [C1D H TF 1G5 [ WHITE # 46A3 [C1D L TF 2G5 [ SLATE # 47A3 [C2C H TF 1G2 [ CONTROL HIGH [ WHITE # 48A3 [C2C L TF 2G2 [ CONTROL LOW [ ORANGE 49A3 [C1C H TF 1G1 [ CONTROL HIGH [ WHITE

FPT2NCM.3 LN=163

### FPT2NCM,4 LN=254

# 50A3 [C1C L TF 2G1 [ CONTROL LOW [ BLUE # 51 A3 [GROUND 3G3 [ GROUND [ BLUE 3G4 [ GROUND [ BLUE # 52A3 [GROUND 3G11 [ BLUE 3G12 [ BLUE # 53A3 [NO CONNECTION [NO CONNECTION 54A3 [NO CONNECTION [NO CONNECTION 55A3 [NO CONNECTION [NO CONNECTION 56A3 [NO CONNECTION [NO CONNECTION 57A3 [I2F H FF 1G16 [ YELLOW # 58A3 [12F L FF 2G16 [ GREEN # 59A3 [I1F H FF 1G15 [ YELLOW # 60A3 [11F L FF 2G15 [ ORANGE # 1 61A3 [I2E H FF 1G12 [ RED # 62A3 [12E L FF 2G12 [BROWN # 63A3 [11E H FF 1G11 [ RED # 64A3 [I1E L FF 2G11 [ GREEN # 65A3 [GROUND 3G15 [BLUE 3G16 BLUE # 

3G2 [ GROUND [ BLUE # 67A3 [C2F H TF 1G14 [ YELLOW # 68A3 [C2F L TF 2G14 [ BLUE # 69A3 [C1F H TF 1G13 [ RED # 70A3 [C1F L TF 2G13 [ SLATE # 71A3 [C2E H TF 1G10 [ RED # 72A3 [C2E L TF 2G10 [ ORANGE # 73A3 [C1E H TF 1G9 [ RED # 74A3 [C1E L TF 2G9 [ BLUE # 75A3 [NO CONNECTION [NO CONNECTION # 76A3 [NO CONNECTION [NO CONNECTION # 77A3 [POWER 90A4 [POWER [YELLOW # 78A3 [GROUND 3G9 [ BLUE 3G10 [ BLUE # 79A3 [NO CONNECTION [NO CONNECTION # 80A3 [GROUND 3G13 [ BLUE 3G14 [ BLUE # 81A3 [NO CONNECTION [NO CONNECTION #

FPT2NCM,5 LN=345

66A3 [GROUND

3G1 [ GROUND [ BLUE

## FPT2NCM,6 LN=436

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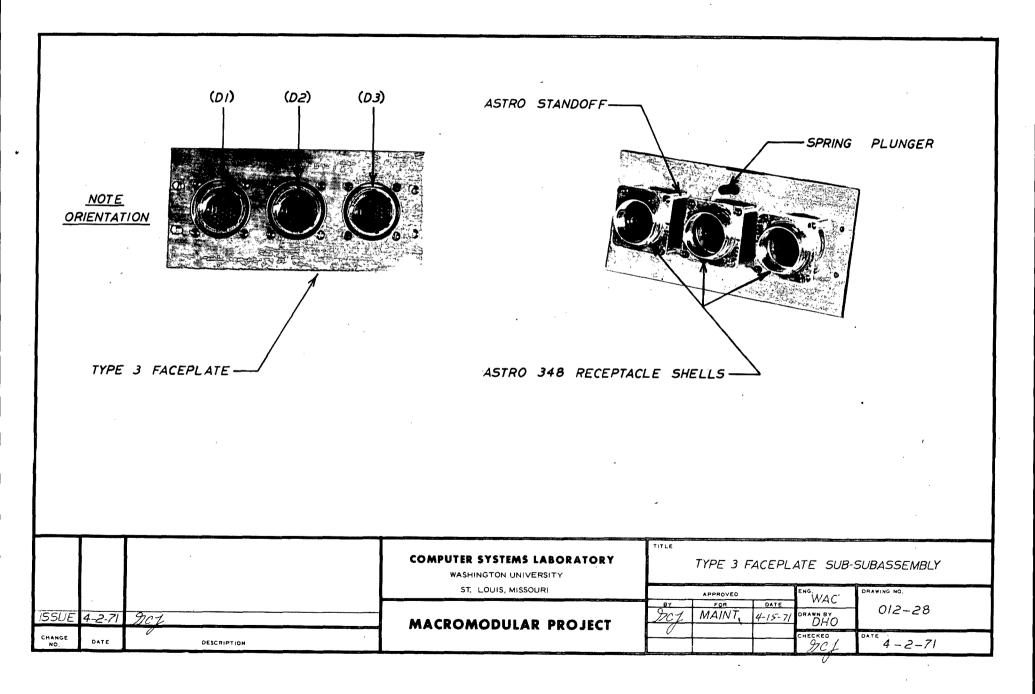
| فد             | 82A3                       | [GROUND [NO CONNECTION  |
|----------------|----------------------------|---|
| #              | 83A3                       | [NO CONNECTION [NO CONNECTION   |
| #              | 84A3                       | [GROUND [NO CONNECTION  |
| #              | 85A3                       | [NO CONNECTION [NO CONNECTION   |
| ,#<br>_#       | 86A3                       | [GROUND [NO CONNECTION  |
| #              | 87A3                       | [NO CONNECTION [NO CONNECTION   |
| #              | 88A3                       | [GROUND [NO CONNECTION  |
| #              | 89A3                       | [NO CONNECTION [NO CONNECTION   |
|                | 90A3                       | [GROUND [NO CONNECTION  |
| #<br>[<br>r    |                            |   |
| i.             | ITCHES                     | ARE WIRED WITH SINGLE WIRES   |
| L<br>#         | 79A4                       | [GROUND [NO CONNECTION  |
|                | 80A4<br>3s1 [              | [FNO L FF<br>NORMAL CLOSED [RED   |
| # ·            | 81A4                       | [GROUND [NO CONNECTION  |
| #              | 82A4<br>352 [              | [FN1 L FF<br>NORMAL CLOSED [RED   |
| #              | 83A4                       | [GROUND [NO CONNECTION  |
| #              | 84A4<br>3s3 [              | [FN2 L FF<br>NORMAL CLOSED [RED   |
| #              | 86A4                       | [NO CONNECTION [NO CONNECTION   |
| #              | 87A4                       | [GROUND [NO CONNECTION  |
| #              | 1S1 [                      | [CODE DRIVER H TF<br>COMMON [YELLOW<br>COMMON [YELLOW<br>COMMON [YELLOW |
| #<br>[<br>[    | 89A4                       | [GROUND [NO CONNECTION  |
| [<br>[<br>[FP] | O OF WI<br>F2NCM<br>RALD C | RING LIST   |
| 1001           |                            |   |

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FPT2NCM,7 LN=527

[26 MARCH 1971

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[TYPE THREE FACEPLATE BOX WIRING LIST. Γ [ # 1A3 [GROUND [NO CONNECTION # 2A3 [GROUND [NO CONNECTION # 3A3 [R3 L TF 24D1 [BIT 3 L [ ORANGE # 4A3 [R3 H TF 23D1 [BIT 3 H [ RED # 5A3 [R2 L TF 33D1 [BIT 2 L [ BLUE # 6A3 [R2 H TF 32D1 [BIT 2 H [ RED # 7A3 [R1 L TF 31D1 [BIT 1 L [ SLATE # 8A3 [R1 H TF 30D1 [BIT 1 H [ YELLOW # 9A3 [RO L TF 37D1 [BIT ZERO L [ ORANGE # 10A3 [RO H TF 36D1 [BIT ZERO H [ YELLOW # 11A3 [R3 L TF 24D2 [BIT 3 L [ ORANGE # 12A3 [R3 H TF 23D2 [BIT 3 H [ RED # 13A3 [R2 L TF 33D2 [BIT 2 L [ BLUE # 14A3 [R2 H TF 32D2 [BIT 2 H [ RED # 15A3 [R1 L TF 31D2 [BIT 1 L [ SLATE # 16A3 [R1 H TF

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# 17A3 [RO L TF 37D2 [BIT ZERO L [ ORANGE # 18A3 [RO H TF 36D2 [BIT ZERO H [ YELLOW # 19A3 [GROUND 22D1 [GROUND [ BLUE # 20A3 [GROUND 22D2 GROUND BLUE # 21A3 [R7 L TF 21D1 [BIT 7 L [ BROWN # 22A3 [R7 H TF 20D1 [BIT 7 H [ YELLOW # 23A3 [R6 L TF 17D1 [BIT 6 L [ GREEN # 24A3 [R6 H TF 16D1 [BIT 6 H [ YELLOW # 25A3 [R5 L TF 28D1 [BIT 5 L [ SLATE # 26A3 [R5 H TF 27D1 [BIT 5 H [ WHITE # 27A3 [R4 L TF 26D1 BIT 4 L BROWN # 28A3 [R4 H TF 25D1 [BIT 4 H [ RED # 29A3 [R7 L TF 21D2 [BIT 7 L [ BROWN # 30A3 [R7 H TF 20D2 [BIT 7 H [ YELLOW # 31A3 [R6 L TF 17D2 [BIT 6 L [ GREEN # 32A3 [R6 H TF 16D2 [BIT 6 H [ YELLOW

## FPT3NC,2 LN=72

30D2 [BIT 1 H [ YELLOW

# 33A3 [R5 L TF 28D2 [BIT 5 L [ SLATE # 34A3 [R5 H TF 27D2 [BIT 5 H [ WHITE # 35A3 [R4 L TF 26D2 [BIT 4 L [ BROWN # 36A3 [R4 H TF 25D2 [BIT 4 H [ RED # 37A3 [GROUND [NO CONNECTION # 38A3 [GROUND [NO CONNECTION # 39A3 [R11 L TF 9D1 [BIT 11 L [ ORANGE # 40A3 [R11 H TF 8D1 [BIT 11 H [ WHITE # 41A3 [R10 L TF 15D1 [BIT 10 L [ GREEN # 42A3 [R10 H TF 14D1 [BIT 10 H [ RED # 43A3 [R9 L TF 13D1 BIT 9 L GREEN # 44A3 [R9 H TF 12D1 [BIT 9 H [ WHITE # 45A3 [R8 L TF 11D1 [BIT 8 L [ BROWN # 46A3 [R8 H TF 10D1 [BIT 8 H [ WHITE # 47A3 [R11 L TF 9D2 [BIT 11 L [ ORANGE # 48A3 [R11 H TF 8D2 [BIT 11 H [ WHITE # 49A3 [R10 L TF

012-32

# 51A3 [GROUND [NO CONNECTION 52A3 [GROUND [NO CONNECTION # 53A3 [R9 L TF 13D2 [BIT 9 L [ GREEN # 54A3 [R9 H TF 12D2 [BIT 9 H [ WHITE # 55A3 [R8 L TF 11D2 [BIT 8 L [ BROWN # 56A3 [R8 H TF 10D2 [BIT 8 H [ WHITE # 57A3 [FN DDR H TF 18D3 [ DD RETURN H [ VIOLET # 58A3 [FN DDR L TF 19D3 DD RETURN L BLUE # 59A3 [FN DD H FF 6D3 [ D DELIVER H [ VIOLET # 60A3 [FN DD L FF 7D3 [ D DELIVER L [ ORANGE # 61A3 [C2DDR H FF 18D2 [ DD RETURN H [ VIOLET # 62A3 [C2DDR L FF 19D2 [ DD RETURN L [ BLUE # 63A3 [C1DDR H FF 18D1 [ DD RETURN H [ VIOLET # 64A3 [C1DDR L FF 19D1 [ DD RETURN L [ BLUE # 65A3 [GROUND [NO CONNECTION 66A3 [GROUND [SIX INCH WIRE WITH GROUND LUG [CONNECT TO D1

FPT3NC.4 LN=254

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15D2 [BIT 10 L [ GREEN

14D2 [BIT 10 H [ RED

50A3 [R10 H TF

### FPT3NC,5 LN=345

# 67A3 [NO CONNECTION [NO CONNECTION 68A3 [NO CONNECTION [NO CONNECTION # 69A3 [NO CONNECTION [NO CONNECTION # 70A3 [NO CONNECTION [NO CONNECTION # 71A3 [C1DD H TF 6D1 [ D DELIVER H [ VIOLET # 72A3 [C1DD L TF 7D1 [ D DELIVER L [ ORANGE # 73A3 [C2DD H TF 6D2 [ D DELIVER H [ VIOLET # 74A3 [C2DD L TF 7D2 [ D DELIVER L [ ORANGE # 75A3 [C2S H FF 29D2 [CABLE SENSE [ GREEN # 76A3 [C1S H FF 29D1 [CABLE SENSE [ GREEN # [THREE WIRES ARE SOLDERED TO PIN 77A3 77A3 [POWER 5D1 [POWER [ YELLOW 5D2 [POWER [ YELLOW 5D3 [POWER [ YELLOW # 78A3 [GROUND [ SIX INCH BLUE WIRE WITH GROUND LUG [CONNECT TO D2 # 79A3 [NO CONNECTION [NO CONNECTION ] # 80A3 [GROUND [ SIX INCH BLUE WIRE WITH GROUND LUG CONNECT GROUND LUG TO CONNECTOR D3 # 81A3 [NO CONNECTION [NO CONNECTION # 82A3 [GROUND 22D3 [GROUND | BLUE # 83A3 [FN3 L FF 24D3 [BIT 3 L [ ORANGE # 84A3 FN3 H FF 23D3 [BIT 3 H [ RED

012-33

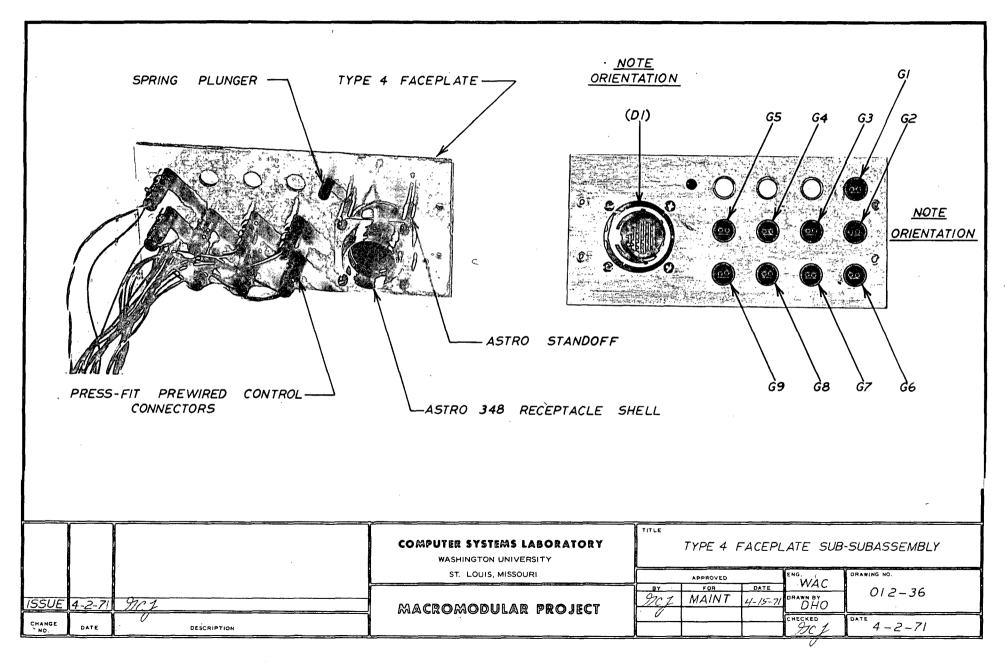
85A3 [FN2 L FF 33D3 [BIT 2 L [ BLUE # 86A3 [FN2 H FF 32D3 [BIT 2 H [ RED # 87A3 [FN1 L FF 31D3 [BIT 1 L [ SLATE # 88A3 [FN1 H FF 30D3 [BIT 1 H [ YELLOW 89A3 [FNO L FF 37D3 [BIT ZERO L [ ORANGE # 90A3 [FNO H FF 36D3 [BIT ZERO H [ YELLOW # THE FOLLOWING CONNECTIONS ARE RESISTORS WITH THEIR LEADS CRIMPED DIRECTLY INTO THE INDICATED CONNECTOR CONTACTS. EXPOSED PORTION OF THE LEADS SHALL BE COVERED BY TEFLON SLEEVING. THE COLOR CODE MAY BE IGNORED. Ε 1D1 [SPARE 1. [ RED 1R601 [ 130 OHM RESISTOR # 2D1 [SPARE 2 [ SLATE 2R601 [ 130 OHM RESISTOR # 1D2 [SPARE 1 [ RED 1R602 [ 130 OHM RESISTOR # 2D2 [SPARE 2 [ SLATE 2R602 [ 130 OHM RESISTOR # 3D1 [SPARE 3 [ YELLOW 1R603 [ 130 OHM RESISTOR # 4D1 [SPARE 4 [ BLUE 2R603 [ 130 OHM RESISTOR # 3D2 [SPARE 3 [ YELLOW 1R604 [ 130 OHM RESISTOR # 4D2 [SPARE 4 [ BLUE 2R604 [ 130 OHM RESISTOR # 34D1 [SPARE 5 [ WHITE

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### FPT3NC,7 LN=524

[GERALD C JOHNS [26 MARCH 1971

012-35



FPT4NC,1 LN=1

[TYPE FOUR FACEPLATE BOX WIRING LIST 1A3 [GRD [NO CONNECTION # 2A3 [GRD [NO CONNECTION # 3A3 [M3 L FF 24D1 [BIT 3 L [ ORANGE # 4A3 [M3 H FF 23D1 [BIT 3 H [ RED # 5A3 [M2 L FF 33D1 [BIT 2 L [ BLUE 6A3 [M2 H FF 32D1 [BIT 2 H [ RED # 7A3 [M1 L FF 31D1 [BIT 1 L [ SLATE # 8A3 [M1 H FF 30D1 [BIT 1 H [ YELLOW # 9A3 [MO L FF 37D1 [BIT ZERO L [ ORANGE # 10A3 [MO H FF 36D1 [BIT ZERO H [ YELLOW # 11A3 [RO CONNECTION [NO CONNECTION # 12A3 [NO CONNECTION [NO CONNECTION # 13A3 [NO CONNECTION [NO CONNECTION 14A3 [NO CONNECTION [NO CONNECTION 15A3 [NO CONNECTION [NO CONNECTION # 16A3 [NO CONNECTION [NO CONNECTION # 17A3 [NO CONNECTION [NO CONNECTION # 18A3 [NO CONNECTION [NO CONNECTION # 19A3 [GRD

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012-37

## FPT4NC,2 LN=72

22D1 [GROUND | BLUE

# 20A3 [GRD [NO CONNECTION # 21A3 [M7 L FF 21D1 BIT 7 L BROWN # 22A3 [M7 H FF 20D1 [BIT 7 H [ YELLOW # 23A3 [M6 L FF 17D1 [BIT 6 L [ GREEN # 24A3 M6 H FF 16D1 [BIT 6 H [ YELLOW # 25A3 [M5 L FF 28D1 [BIT 5 L [ SLATE # 26A3 [M5 H FF 27D1 [BIT 5 H [ WHITE # 27A3 [M4 L FF 26D1 [BIT 4 L [ BROWN # 28A3 [M4 H FF 25D1 [BIT 4 H [ RED # 29A3 [NO CONNECTION [NO CONNECTION # 30A3 [NO CONNECTION [NO CONNECTION # 31A3 [NO CONNECTION [NO CONNECTION # 32A3 [NO CONNECTION [NO CONNECTION 33A3 [NO CONNECTION [NO CONNECTION # 34A3 [NO CONNECTION [NO CONNECTION # 35A3 [NO CONNECTION [NO CONNECTION # 36A3 [NO CONNECTION [NO CONNECTION # 37A3 [GRD 3G5 [ BLUE # 

> 38A3 [GRD 3G9 [ BLUE

### FPT4NC,3 LN=163

# 39A3 [M11 L FF 9D1 [BIT 11 L [ ORANGE # 40A3 [M11 H FF 8D1 [BIT 11 H [ WHITE # 41A3 [M10 L FF 15D1 [BIT 10 L [ GREEN # 42A3 [M10 H FF 14D1 [BIT 10 H [ RED # 43A3 [M9 L FF 13D1 [BIT 9 L [ GREEN # 44A3 M9 H FF 12D1 [BIT 9 H [ WHITE # 45A3 [M8 L FF 11D1 [BIT 8 L [ BROWN # 46A3 [M8 H FF 10D1 [BIT 8 H [ WHITE # 47A3 [CO H TF 1G2 [ CONTROL HIGH [ WHITE # 48A3 [CO L TF 2G2 [ CONTROL LOW [ ORANGE # 49A3 [C1 H TF 1G3 [ CONTROL HIGH [ WHITE # 50A3 [C1 L TF 2G3 [ CONTROL LOW [ GREEN # 51A3 [GRD 3G4 [ GROUND [ BLUE 3G8 [ BLUE # 52A3 [GRD 3G3 [ GROUND [ BLUE 3G7 [ BLUE # 53A3 [C2 H TF 1G4 [ CONTROL HIGH [ WHITE **'** #

54A3 [C2 L TF 2G4 [ CONTROL LOW [ BROWN # 55A3 [C3 H TF 1G5 [ WHITE # 56A3 [C3 L TF 2G5 [SLATE # 57A3 [C4 H TF 1G6 [ YELLOW # 58A3 [C4 L TF 2G6 [ BLUE # 59A3 [C5 H TF 1G7 [ YELLOW # 60A3 [C5 L TF 2G7 [ORANGE # 61A3 [C6 H TF 1G8 [ YELLOW # 62A3 [C6 L TF 2G8 [ GREEN # '63A3 [MR H TF 18D1 [ DD RETURN H [ VIOLET # 64A3 [MR L TF 19D1 [ DD RETURN L [ BLUE . # 65A3 [GRD 3G2 [ GROUND [ BLUE # 66A3 [GRD 3G6 [ BLUE # 67A3 [C7 H TF 1G9 [ RED # 68A3 [C7 L TF 2G9 BLUE # 69A3 [I H FF 1G1 [ CONTROL HIGH [ WHITE

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012-41

70A3 [I L FF 2G1 [ CONTROL LOW [ BLUE # 71A3 [MD H FF 6D1 [ D DELIVER H [ VIOLET # 72A3 [MD L FF 7D1 [ D DELIVER L [ ORANGE # 73A3 [NO CONNECTION [NO CONNECTION ŧ 74A3 [NO CONNECTION [NO CONNECTION # 75A3 [NO CONNECTION [NO CONNECTION # 76A3 [NO CONNECTION 29D1 [CABLE SENSE [ GREEN # 77A3 [POWER 5D1 [POWER [ YELLOW # 78A3 [GRD 3G1 [ GROUND [ BLUE # 79A3 [NO CONNECTIOM [NO CONNECTION # 80A3 [GRD [ SIX INCH BLUE WIRE WITH GROUND LUG [CONNECT TO D1 # 81A3 [NO CONNECTION [NO CONNECTION # 82A3 [GRD [NO CONNECTION. # 83A3 [NO CONNECTION [NO CONNECTION # 84A3 [GRD [NO CONNECTION # 85A3 [NO CONNECTION [NO CONNECTION # 86A3 [GRD [NO CONNECTION # 87A3 [NO CONNECTION [NO CONNECTION

FPT4NC,5 LN=345

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[GERALD C JOHNS [29 SEPT 1970

4D1 [SPARE 4 [ BLUE

1R601 [ 130 OHM RESISTOR 2D1 [SPARE 2 [ SLATE 2R601 [ 130 OHM RESISTOR

1D1 [SPARE 1 [ RED 1R601 [ 130 OHM RESISTOR

[ THE FOLLOWING CONNECTIONS ARE RESISTORS WITH THEIR LEADS CRIMPED DIRECTLY INTO THE INDICATED CONNECTOR CONTACTS. THE EXPOSED PORTION OF THE LEADS SHALL BE COVERED BY TEFLON SLEEVING. THE COLOR CODE MAY BE IGNORED.

FPT4NC.6 LN=436

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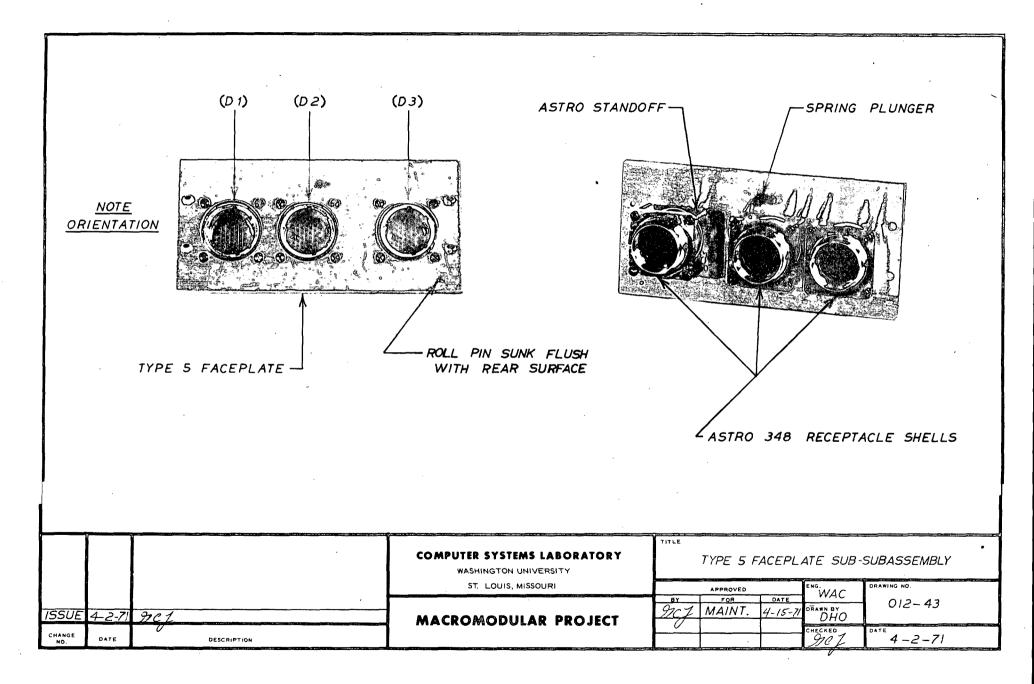
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FPT5NC,1 LN=1

FPT5C [FACEPLATE TYPE 5 WIRING LIST # 1A3 [GRD [SIX INCH WIRE WITH GROUND LUG [CONNECT TO D1 # 2A3 [GRD [SIX INCH WIRE WITH GROUND LUG [CONNECT TO D2 # 3A3 [B1-3 L TF 24D1 [BIT 3 L [ ORANGE # 4A3 [B1-3 H TF 23D1 [BIT 3 H [ RED # 5A3 [B1-2 L TF 33D1 [BIT 2 L [ BLUE # 6A3 [B1-2 H TF 32D1 [BIT 2 H [ RED # 7A3 [B1-1 L TF 31D1 [BIT 1 L [ SLATE # 8A3 [B1-1 H TF 30D1 [BIT 1 H [ YELLOW # 9A3 [B1-0 L TF 37D1 [BIT ZERO L [ ORANGE # 10A3 [B1-0 H TF 36D1 [BIT ZERO H [ YELLOW # 11A3 [B2-3 L TF 24D2 [BIT 3 L [ ORANGE # 12A3 [B2-3 H TF 23D2 BIT 3 H RED #` 13A3 [B2-2 L TF 33D2 [BIT 2 L [ BLUE # 14A3 [B2-2 H TF 32D2 [BIT 2 H [ RED # 15A3 [B2-1 L TF 31 D2 BIT 1 L SLATE

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FPT5NC,2 LN=72

# 16A3 [B2-1 H TF 30D2 [BIT 1 H [ YELLOW # 17A3 [B2-0 L TF 37D2 [BIT ZERO L [ ORANGE Ħ 18A3 [B2-0 H TF 36D2 [BIT ZERO H [ YELLOW # 19A3 [GRD 22D1 [GROUND [ BLUE # 20A3 [GRD 22D2 [GROUND [ BLUE # 21A3 [B1-7 L TF 21D1 [BIT 7 L [ BROWN # 22A3 [B1-7 H TF 20D1 [BIT 7 H [ YELLOW # 23A3 [B1-6 L TF 17D1 BIT 6 L GREEN # 24A3 [B1-6 H TF 16D1 [BIT 6 H [ YELLOW # 25A3 [B1-5 L TF 28D1 [BIT 5 L [ SLATE # 26A3 [B1-5 H TF 27D1 [BIT 5 H [ WHITE # 26D1 [BIT 4 L | BROWN # 28A3 [B1-4 H TF 25D1 [BIT 4 H [ RED # 29A3 [B2-7 L TF 21D2 [BIT 7 L [ BROWN # 30A3 [B2-7 H TF 20D2 [BIT 7 H [ YELLOW # 31A3 [B2-6 L TF 17D2 BIT 6 L GREEN

# FPT5NC,3 LN=163

| #          |   |
|------------|---|
| #          | 32A3 [B2-6 H TF<br>16D2 [BIT 6 H [ YELLOW |
| "          | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>    |
| #          | 34A3 [B2-5 H TF<br>27D2 [BIT 5 H [ WHITE  |
| #          | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>    |
| #<br><br># | 36A3 [B2-4 H TF<br>25D2 [BIT 4 H [ RED    |
| π<br>#     | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>    |
| #          | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>    |
|            | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>    |
| #          | 40A3 [B1-11 H TF<br>8D1 [BIT 11 H [ WHITE |
|            | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>    |
| #          | 42A3 [B1-10 H TF<br>14D1 [BIT 10 H [ RED  |
|            | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>    |
| #          | 44A3 [B1-9 H TF<br>12D1 [BIT 9 H [ WHITE  |
| #          | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>    |
| #          | 46A3 [B1-8 H TF<br>10D1 [BIT 8 H [ WHITE  |
| Π          | >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>    |
| #          | 48A3 [B2-11 H TF                          |

8D2 [BIT 11 H [ WHITE # 49A3 [B2-10 L TF 15D2 [BIT 10 L [ GREEN # 50A3 B2-10 H TF 14D2 [BIT 10 H [ RED # 51A3 [GRD [NO CONNECTION # 52A3 [GRD [NO CONNECTION # 53A3 [B2-9 L TF 13D2 [BIT 9 L [ GREEN # 54A3 [B2-9 H TF 12D2 [BIT 9 H [ WHITE # 55A3 [B2-8 L TF 11D2 BIT 8 L BROWN # 56A3 [B2-8 H TF 10D2 [BIT 8 H [ WHITE # 57A3 [NO CONNECTION [NO CONNECTION # 58A3 [NO CONNECTION [NO CONNECTION # 59A3 [NO CONNECTION [NO CONNECTION # . 60A3 [NO CONNECTION [NO CONNECTION # 61A3 [B2DDR H FF 18D2 [ DD RETURN H [ VIOLET # 62A3 [B2DDR L FF 19D2 [ DD RETURN L [ BLUE `# 63A3 [B1DDR H FF 18D1 [ DD RETURN H [ VIOLET # 64A3 [B1DDR L FF 19D1 [ DD RETURN L [ BLUE # 

65A3 [GRD [NO CONNECTION

# 66A3 [GRD [NO CONNECTION # 67A3 [NO CONNECTION [NO CONNECTION # 68A3 [NO CONNECTION [NO CONNECTION # 69A3 [NO CONNECTION [NO CONNECTION # 70A3 [NO CONNECTION [NO CONNECTION # 71A3 [B1DD H TF 6D1 [ D DELIVER H [ VIOLET # 72A3 [B1DD L TF 7D1 [ D DELIVER L [ ORANGE # 73A3 [B2DD H TF 6D2 [ D DELIVER H [ VIOLET # 74A3 [B2DD L TF 7D2 [ D DELIVER L [ ORANGE # 75A3 [B2S H FF 29D2 [CABLE SENSE [ GREEN # 76A3 [B1S H FF 29D1 [CABLE SENSE [ GREEN # [FOUR WIRES ARE SOLDERED TO PIN 77A3 77A3 [POWER FF 5D1 [POWER [ YELLOW 5D2 [POWER [ YELLOW 5D3 POWER VELLOW 90A4 [POWER [PINS 78A3 THROUGH 90A3 INCLUSIVE HAVE NO CONNECTION ONLY EVEN NUMBERED PINS OF CONNECTOR A4 ARE USED WITH THE EXCEPTIONS OF 1A4 AND 5A4. ALL OTHER ODD NUMBERED PINS ARE [NO CONNECTION. L # [GRD 1A4 22D3 [GROUND [ BLUE # 

FPT5NC.5 LN=345

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2A4 [A3 L FF 24D3 [BIT 3 L [ ORANGE # 4A4 [A3 H FF 23D3 [BIT 3 H [ RED ŧ! 5A4 [GRD [SIX INCH WIRE WITH GROUND LUG [CONNECT TO D3 # 6A4 [A2 L FF 33D3 [BIT 2 L [ BLUE # 8A4 [A2 H FF 32D3 [BIT 2 H [ RED # 10A4 [A1 L FF 31D3 [BIT 1 L [ SLATE # 12A4 [A1 H FF 30D3 [BIT 1 H [ YELLOW # 14A4 TAO L FF 37D3 [BIT ZERO L [ ORANGE # 16A4 [AO H FF 36D3 [BIT ZERO H [ YELLOW # 18A4 [A7 L FF 21D3 [BIT 7 L [ BROWN # 20A4 [A7 H FF 20D3 [BIT 7 H [ YELLOW # 22A4 [A6 L FF 17D3 [BIT 6 L [ GREEN # 24A4 [A6 H FF 16D3 [BIT 6 H [ YELLOW Ħ 26A4 [A5 L FF 28D3 [BIT 5 L [ SLATE # 28A4 [A5 H FF 27D3 [BIT 5 H [ WHITE # 30A4 [A4 L FF 26D3 [BIT 4 L | BROWN # 32A4 [A4 H FF

### FPT5NC,7 LN=525

25D3 [BIT 4 H [ RED # 34A4 [A11 L FF 9D3 [BIT 11 L [ ORANGE # 36A4 [A11 H FF 8D3 [BIT 11 H [ WHITE # 38A4 [A10 L FF 15D3 [BIT 10 L [ GREEN # 40A4 [A10 H FF 14D3 [BIT 10 H [ RED # 42A4 [A9 L FF 13D3 [BIT 9 L [ GREEN # 44A4 [A9 H FF 12D3 [BIT 9 H [ WHITE # 46A4 [A8 L FF 11D3 [BIT 8 L [ BROWN # 48A4 [A8 H FF 10D3 [BIT 8 H [ WHITE # 50A4 [ARGDDR H TF 18D3 [ DD RETURN H [ VIOLET # 52A4 [ARGDDR L TF 19D3 [ DD RETURN L [ BLUE ŧŧ 54A4 [ARGDD H FF 6D3 [ D DELIVER H [ VIOLET # 56A4 [ARGDD L FF 7D3 [ D DELIVER L [ ORANGE # [PINS 58A4 THROUGH 88A4 INCLUSIVE ARE NO CONNECTION. Ł 90A4 [POWER [SEE 77A3 # 

[THE FOLLOWING ARE RESISTORS WITH THEIR LEADS CRIMPED DIRECTLY INTO THE INDICATED CONNECTOR CONTACTS. THE LEADS SHALL BE COVERED BY TEFLON SLEEVING, AND THE COLOR CODE MAY BE IGNORED. [

1R601 [ 130 OHM RESISTOR

012-51

1R606 [ 130 OHM RESISTOR 34D2 [SPARE 5 [ WHITE 2R606 [ 130 OHM RESISTOR 35D2 [SPARE 6 | BLUE 1R607 1D3 [SPARE 1 [ RED 2R607 2D3 [SPARE 2 [ SLATE 1R608 3D3 [SPARE 3 [ YELLOW 2R608 4D3 [SPARE 4 [ BLUE 1R609 34D3 [SPARE 5 [ WHITE

2R605 [ 130 OHM RESISTOR 4D2 [SPARE 4 [ BLUE

2R604 [ 130 OHM RESISTOR 2D2 [SPARE 2 [ SLATE

2R603 [ 130 OHM RESISTOR 35D1 [SPARE 6 [ BLUE

2R602 [ 130 OHM RESISTOR 4D1 [SPARE 4 [ BLUE

2R601 [ 130 OHM RESISTOR 2D1 [SPARE 2 [ SLATE

1D1 [SPARE 1 [ RED

FPT5NC,10 LN=614

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# FPT5NC,11 LN=705

FPT5NC [GERALD C JOHNS [29 SEPT 1970

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012-54

16A3 [GROUND 3G1 [ GROUND [ BLUE

15A3 [GROUND 3G5 [ BLUE

14A3 [ANALOG 1 RETURN 2V2 [ORANGE

13A3 [ANALOG 1 OUT 1V2 [RED

12A3 [NO CONNECTION

11A3 [NO CONNECTION

10A3 [GROUND 3V2 [BLUE

9A3 [ NO CONNECTION

8A3 [NO CONNECTION

7A3 [NO CONNECTION

6A3 [ANALOG O RETURN 2V1 [GREEN

5A3 [ANALOG O OUT 1V1 [WHITE

4A3 [NO CONNECTION

3A3 [NO CONNECTION

2A3 [GROUND 3V1 [BLUE 

1A3 [NO CONNECTION

[FACEPLATE TYPE 6 WIRING LIST

FPT6C

FPT6NC,1 LN=1

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17A3 [INCV-H 1G5 [ WHITE # 18A3 [INCV-L .2G5 [ SLATE # 19A3 [INLDO-L 2G1 [ CONTROL LOW [ BLUE # 20A3 [INLDO-H 1G1 [ CONTROL HIGH [ WHITE # 21A3 [INLD1-L 2G3 [ CONTROL LOW [ GREEN # 22A3 [INLD1-H 1G3 [ CONTROL HIGH [ WHITE # 23A3 [GROUND 3G3 [ GROUND [ BLUE # 24A3 [GROUND 3G4 [ GROUND [ BLUE # 25A3 [TLD1-H 1G4 [ CONTROL HIGH [ WHITE # 26A3 [TLD1-L 2G4 [ CONTROL LOW [ BROWN # 27A3 [TLD0-H 1G2 [ CONTROL HIGH [ WHITE # 28A3 [TLDO-L 2G2 [ CONTROL LOW [ ORANGE # 29A3 [TCV-H 1G6 [ YELLOW # 30A3 [TCV-J 2G6 [ BLUE # 31A3 [UNIPOLAR-L 282 [ NORMAL OPEN # 

32A3 [GROUND

FPT6NC.2 LN=72

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012-56

3G6 [ BLUE # 33A3 [SIGN-H 3S1 [ NORMAL CLOSED [RED # 34A3 3G2 [ GROUND [ BLUE # 35A3 [SHIFT 1-L 2S4 [ NORMAL OPEN # 36A3 [NO CONNECTION # 37A3 [SHIFT O-L 2S3 [ NORMAL OPEN [PINS 38A3 THROUGH 57A3 INCLUSIVE ARE NO CONNECTION # 59A3 [UNB OUT H 1G8 [YELLOW # 60A3 [UNB OUT L 2G8 [ GREEN # 61A3 [LOGIC HIGH 1S1 [ COMMON [YELLOW 1S2 [ COMMON [YELLOW 1S3 [ COMMON [YELLOW 1S4 COMMON YELLOW # 62A3 [NO CONNECTION # 63A3 [NO CONNECTION # **>>>>>>>>>** 64A3 [NO CONNECTION 65A3 [UNBLANK 1V3 [YELLOW # 66A3 [GROUND 2V3 [BLUE # 67A3 [GROUND

FPT6NC.3 LN=163

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# 69A3 [UNB IN-H 1G7 [ YELLOW #

70A3 [UNB IN-L 2G7 [ ORANGE

[END OF WIRING LIST

[10 NOVEMBER 1970 [GERALD C JOHNS

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[FPT6NC

3V3 [BLUE # 

FPT6NC,4 LN=254

### FAN-CENTER CHANNEL CONNECTOR

# Pin Assignments

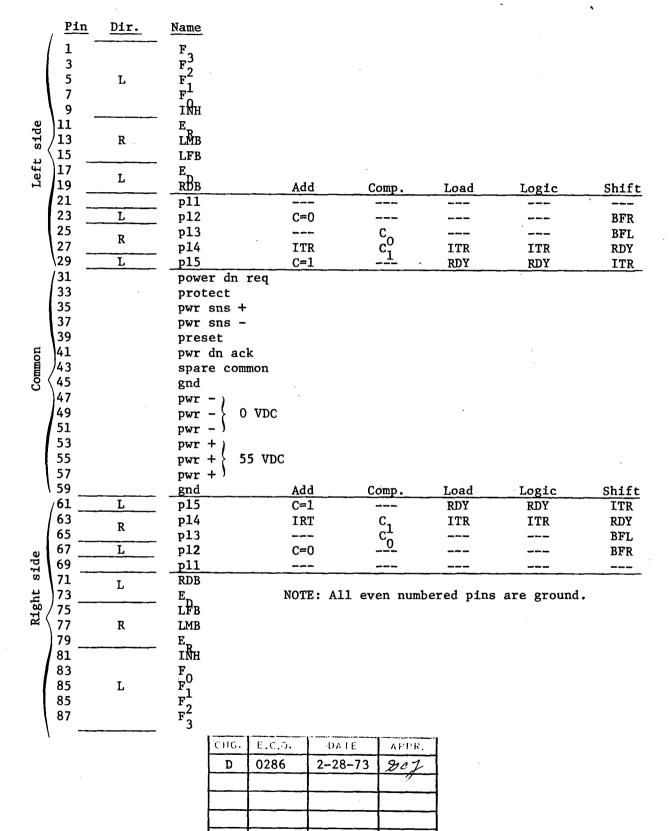
| 1    | Power + TL  | 47 | NC                 |
|------|---|----|--------------------|
| 3    | +   | 49 | Power Down Request |
| 5    | +   | 51 | Data Protect TR    |
| 7    | + .   | 53 | Preset             |
| 9    | +   | 55 | Power Down Ack     |
| 11   | +   | 57 | Spare l            |
| 13   | + 、   | 59 | Sense -            |
| 15   | Power - TL  | 61 | Sense +            |
| 17   | · _   | 63 | Power - TR         |
| 19   | -   | 65 | -                  |
| 21   | -   | 67 | -                  |
| 23   | -<br>-  | 69 | -                  |
| 25   | <b>-</b>  | 71 | -                  |
| 27   | -   | 73 |                    |
| 29   | Sense + TL  | 75 | -                  |
| 31   | Sense - TL  | 77 | Power + TR         |
| 33   | Spare 1   | 79 | . <b>+</b>         |
| 35   | Power Down Ack  | 81 | · · · · •          |
| 37   | Preset  | 83 | +                  |
| 39   | Data Protect TL   | 85 | +                  |
| 41   | Power Down Request TL   | 87 | +                  |
| 43   | NC  | 89 | +                  |
| 45   | NC  |    |                    |
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D 0286 2-28-73 9/C7 All even numbered pins are ground

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#### Pin Assignments Lateral Channel to Module



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| MODULE CONNECTOR FAN CENTER MODULE CONNECTOR MODULE CONNECTOR CONNECTOR PIN 2 PIN 90 PIN 1 PIN 89 PIN 1 |   |   |  |           | SAME NUMBERING ON<br>ODULE CONNECTORS |           | ·   |        |       |     |
|---|---|---|--|-----------|---------------------------------------|-----------|-----|--------|-------|-----|
| PIN90 PIN 2<br>PIN 90 PIN 2<br>PIN 90 PIN 2<br>PIN 90 PIN 2   |   | · |  |           |                                       |           |     |        |       |     |
| PIN90 PIN 2<br>PIN 90 PIN 2<br>PIN 90 PIN 2   | 1 |   |  |           |                                       |           |     |        |       |     |
| PIN90 PIN 2 PIN 90 PIN 2  |   | L |  | PIN 89    | PIN 1                                 | )<br>PIN  | 189 |        | PIN 1 |     |
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|   |   |   | CONNECTOR                              | CONNECTOR |                                       | CONNECTOR |     | NECTOR |       |     |
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| UNCLASSIFIED<br>Security Classification  |   |
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|  | RUL DAIA · K & D<br>annotation must be entered when the overall report is classified) |
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| St. Louis, Missouri  |   |
| 3. REPORT TITLE  |   |
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| 13. ABSTRACT   | }   |
| Metal finishes, assembly specificat<br>for manufacture of printed circuit board            | tions for printed circuit boards, standards   |
| cal properties of macromodular data and  |   |
|  | stor networks, description and data sheets  |
| of BERNE, Inc. CTS 750 cermet resistor n   | etworks, wiring paths and pictorial   |
| assembly drawings of types of faceplate  | subassemblies are given.  |
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DD 1 NOV 41473 AEPLACES DO FORM 1473, 1 JAN 64, WHICH 18 OBSOLETE FOR ARMY USE.

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| UNCLASSIFIED<br>Security Classification |        |       |                   |      |    |  |
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| 14. KEY WORDS                           |        |       | LINK B<br>ROLE WT |      |    |  |
| Printed Circuit Boards                  | ROLE W | T ROL | E WT              | ROLE | WT |  |
| Macromodules                            |        |       |                   |      |    |  |
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| Printed Circuit Standards               |        |       |                   |      |    |  |
| Macromodule Assembly Specifications     |        |       | :                 |      |    |  |
| Macromodule Data Cable                  |        |       |                   |      |    |  |
| Macromodule Control Cable               |        |       |                   |      |    |  |
| Macromodule Interlock Network           |        |       |                   |      |    |  |
| Macromodule Faceplate Subassembly       |        |       |                   |      |    |  |
| Macromodule Faceplate Wiring List       |        |       |                   |      |    |  |
| Macromodule Pin Assignments             |        |       |                   |      |    |  |
| Macromodule Lateral Channel             |        |       |                   |      |    |  |
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